



TAOGLAS®



Datasheet

WarriorX

Part No:
PA.760.A

Description:

WarriorX Wideband (600-6000MHz) Antenna for 5G NR & 4G Bands

Features:

- Patent Pending Innovative Design
- High Efficiency Wideband Antenna, Covering 600 to 6000 MHz
- Supporting all 5G NR Bands
- 600MHz 5G/4G Band 71 Support
- Surface Mount Distribution (SMD) - Supplied on Tape & Reel
- Dimensions: 40 x 5 x 6 mm
- Manufactured in an IATF16949 Certified Facility
- RoHS & REACH Compliant

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1. Introduction



The Taoglas, WarriorX PA.760.A is a patent pending 5G/4G, high-efficiency, wideband(600-6000MHz) SMD ceramic antenna, designed to cover newly established 5G NR bands for worldwide deployment and worldwide 4G bands. It uses high grade custom ceramic and innovative design techniques to deliver the highest efficiencies in a small footprint across all bands when mounted on the device's main PCB.

The PA.760 is backward compatible for global 3G/2G applications if required. The PA.760 is delivered on tape and reel and mounted securely during the device PCB reflow process. The PA.760 also operates with great efficiency on worldwide NB-IoT and CAT-M frequency bands.

Typical applications include:

- Transportation
- Robotics
- Wearables
- Autonomous/UAVs
- Industrial IoT

The PA.760 is more resistant to detuning compared to other antenna integrations. If tuning is required it can be tuned for the device environment using a matching circuit, or other techniques on the main PCB itself. There is no need for new tooling, thereby saving money if customization is required.

The PA.760.A is manufactured in our IATF16949 approved production facility and made from highly reliable and robust ceramic that is currently used by world leading automotive manufacturers in extremely challenging environments.

The PA.760 has a small profile, 40*6*5mm, allowing for ease of integration. Contact your regional Taoglas customer support team to request these services or additional support to integrate and test this antenna's performance in your device.

2. Specifications

Electrical							
Band	Frequency (MHz)	Efficiency (%)	Average Gain (dB)	Peak Gain (dBi)	Impedance	Polarization	Radiation Pattern
5G NR/4G Band 71	617~698	40.5	-3.9	-0.7	50 Ω	Linear	Omni
4G/3G Band 12,13,14,17,28,29	698~806	49.6	-3.1	0.5			
4G/3G Band 5,8,18,19,20,26,27	824~960	53.2	-2.7	1			
5G NR/4G Band 21,32,74,75,76	1427~1518	28.8	-5.4	-0.5			
4G/3G Band 1,2,3,4,9,23,25,35,39,66	1710~2200	66.8	-1.7	3.4			
4G/3G Band 7,38,41	2490~2690	53.8	-2.7	2.9			
5G NR Band 22,42,48,77,78,79	3300~5000	42.6	-3.7	4.3			
LTE5200/ Wi-Fi 5800	5150~5925	51.5	-2.9	3			

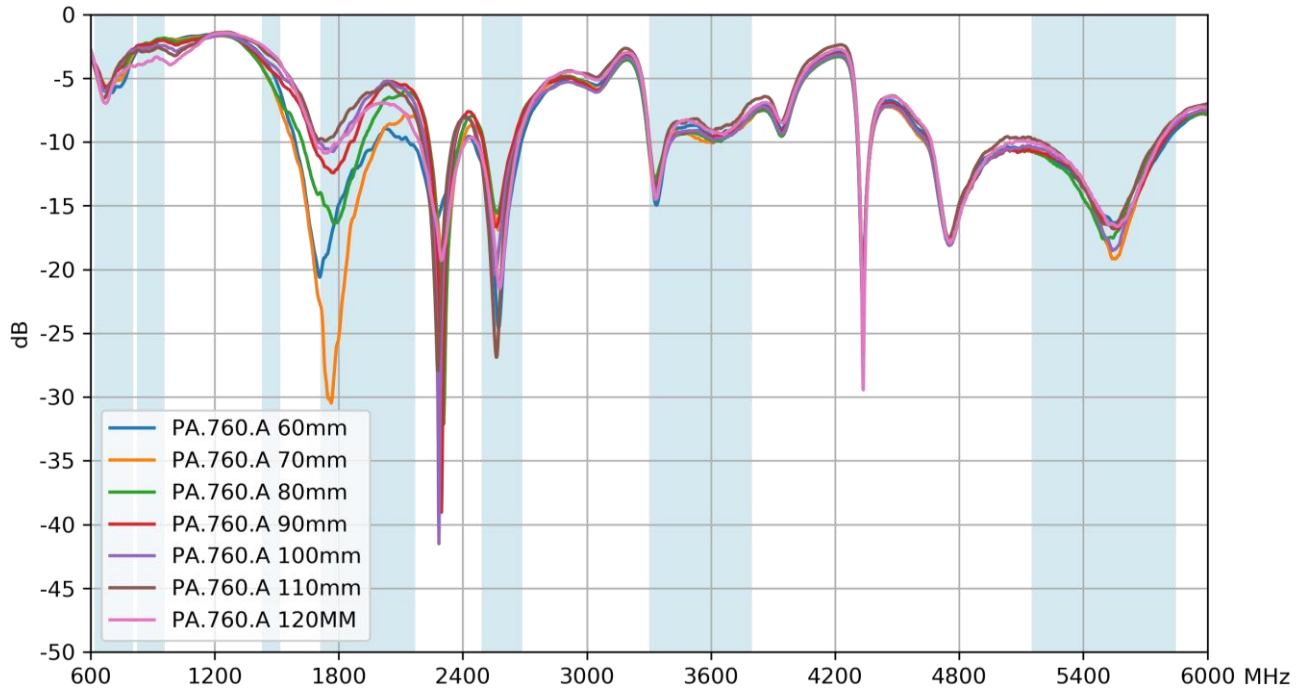
*The PA.760.A antenna performance was measured on a 120x45 ground plane (PAD.760.A)

Mechanical	
Dimensions	40*6*5mm
Material	Ceramic
Termination	Ag (environmental Pb free) - Solder Pad
EVB Connector	SMA-Female
Weight	3g
Environmental	
Temperature Range	-40°C to 85°C
Moisture Sensitivity	Level 3

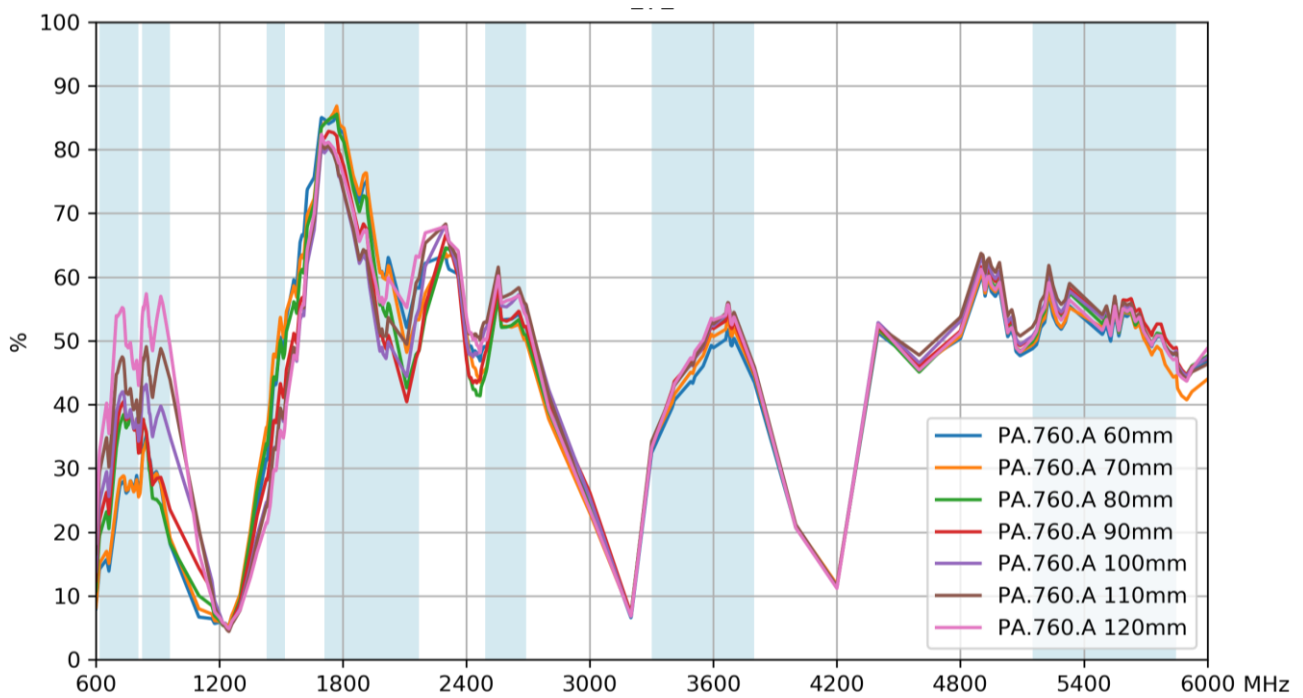
5G/4G Bands			
Band Number	5G NR / FR1 / LTE / LTE-Advanced / WCDMA / HSPA / HSPA+ / TD-SCDMA		
	Uplink	Downlink	Covered
1	UL: 1920 to 1980	DL: 2110 to 2170	✓
2	UL: 1850 to 1910	DL: 1930 to 1990	✓
3	UL: 1710 to 1785	DL: 1805 to 1880	✓
4	UL: 1710 to 1755	DL: 2110 to 2155	✓
5	UL: 824 to 849	DL: 869 to 894	✓
7	UL: 2500 to 2570	DL: 2620 to 2690	✓
8	UL: 880 to 915	DL: 925 to 960	✓
9	UL: 1749.9 to 1784.9	DL: 1844.9 to 1879.9	✓
11	UL: 1427.9 to 1447.9	DL: 1475.9 to 1495.9	✓
12	UL: 699 to 716	DL: 729 to 746	✓
13	UL: 777 to 787	DL: 746 to 756	✓
14	UL: 788 to 798	DL: 758 to 768	✓
17	UL: 704 to 716	DL: 734 to 746	✓
18	UL: 815 to 830	DL: 860 to 875	✓
19	UL: 830 to 845	DL: 875 to 890	✓
20	UL: 832 to 862	DL: 791 to 821	✓
21	UL: 1447.9 to 1462.9	DL: 1495.9 to 1510.9	✓
22	UL: 3410 to 3490	DL: 3510 to 3590	✓
23	UL: 2000 to 2020	DL: 2180 to 2200	✓
24	UL: 1625.5 to 1660.5	DL: 1525 to 1559	✓
25	UL: 1850 to 1915	DL: 1930 to 1995	✓
26	UL: 814 to 849	DL: 859 to 894	✓
27	UL: 807 to 824	DL: 852 to 869	✓
28	UL: 703 to 748	DL: 758 to 803	✓
29	UL: -	DL: 717 to 728	✓
30	UL: 2305 to 2315	DL: 2350 to 2360	✓
31	UL: 452.5 to 457.5	DL: 462.5 to 467.5	✗
32	UL: -	DL: 1452 – 1496	✓
35		1850 to 1910	✓
38		2570 to 2620	✓
39		1880 to 1920	✓
40		2300 to 2400	✓
41		2496 to 2690	✓
42		3400 to 3600	✓
43		3600 to 3800	✓
48		3550 to 3700	✓
66	UL: 1710-1780	DL: 2110-2200	✓
71		617 to 698	✓
74/75/76		1427 to 1518	✓
77		3300 to 4200	✓
78		3300 to 3800	✓
79		4400 to 5000	✓

3. Antenna Characteristics

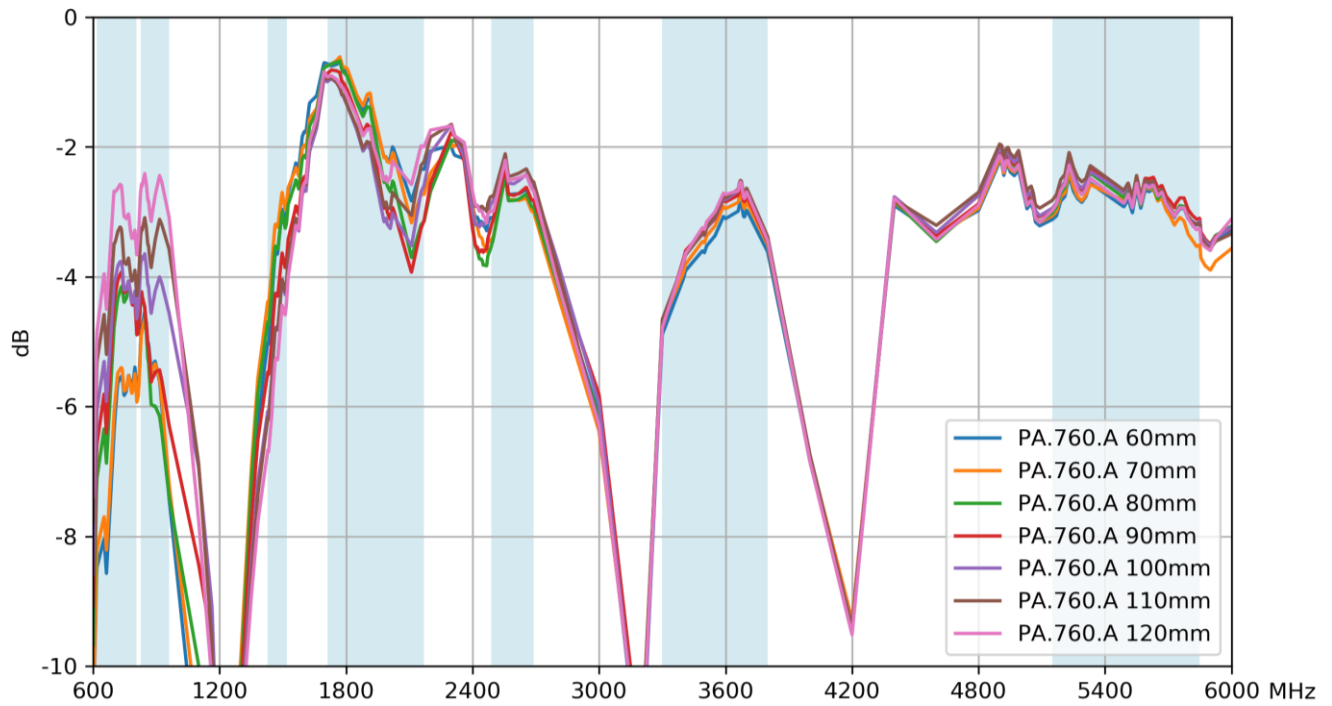
3.1 Return Loss



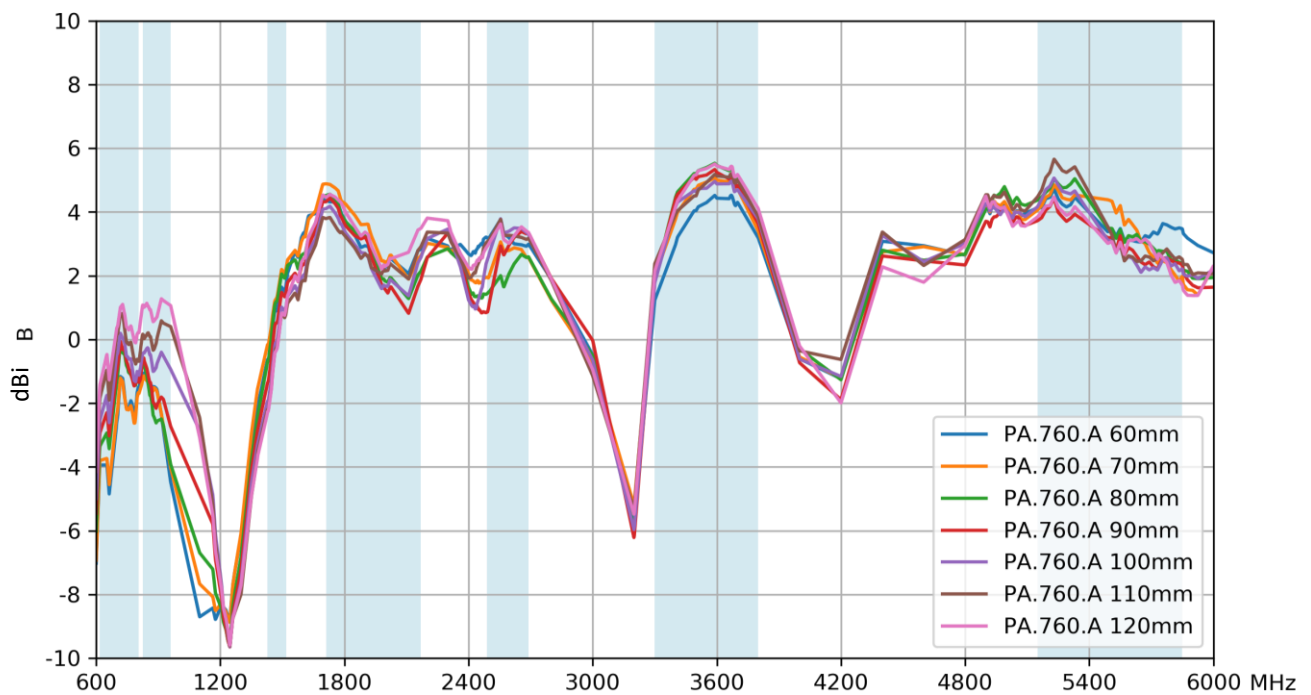
3.2 Efficiency



3.3 Average Gain

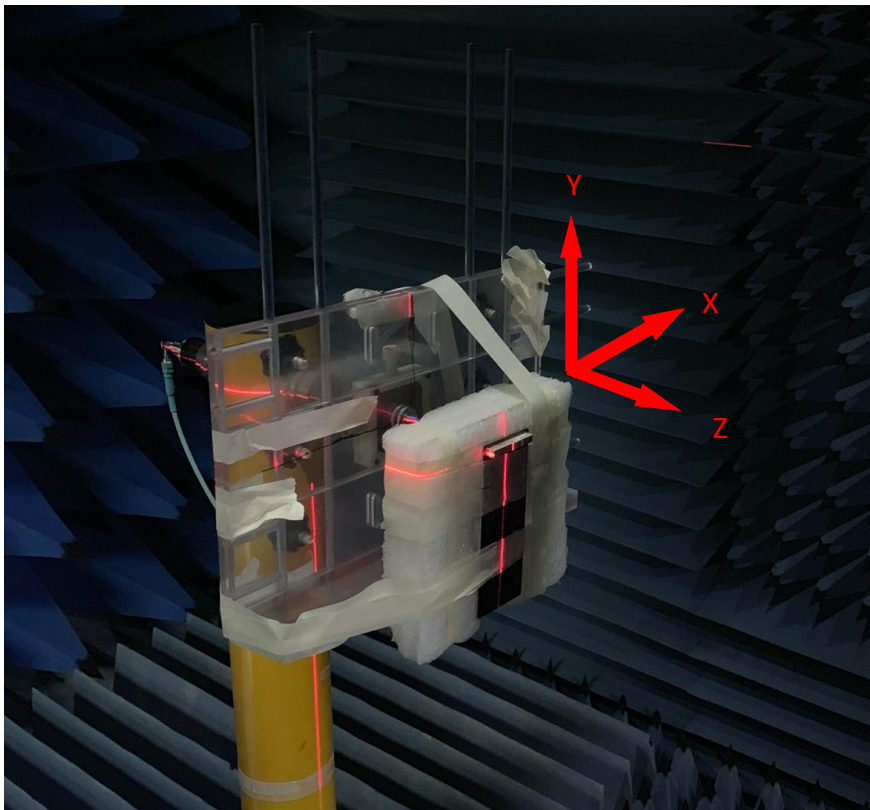


3.4 Peak Gain



4. 2D Radiation Patterns

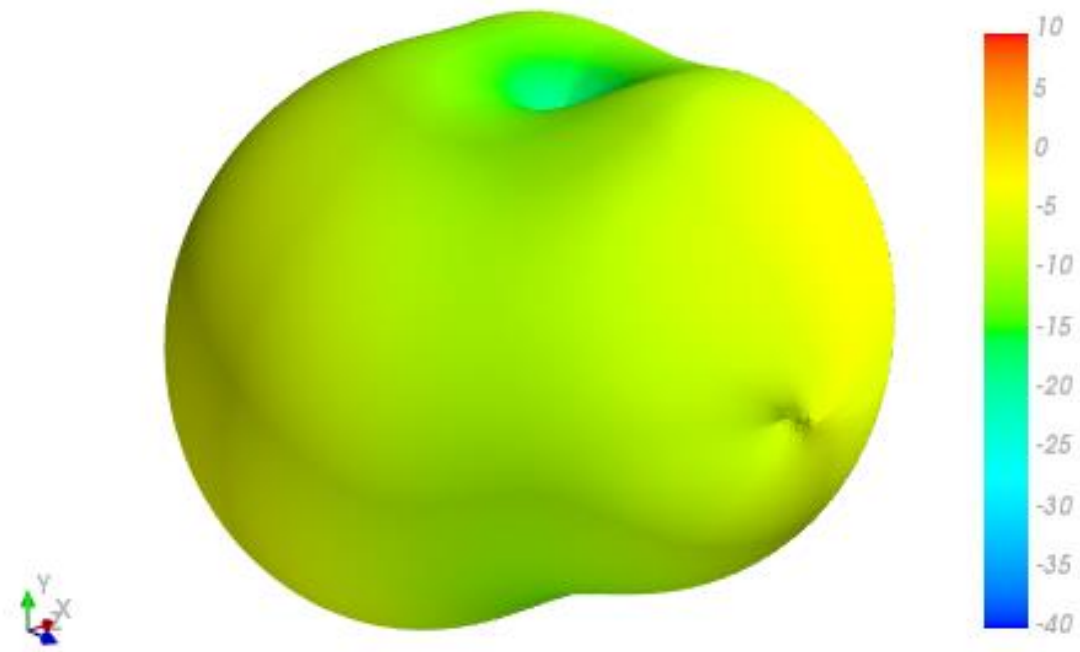
4.1 Test Setup



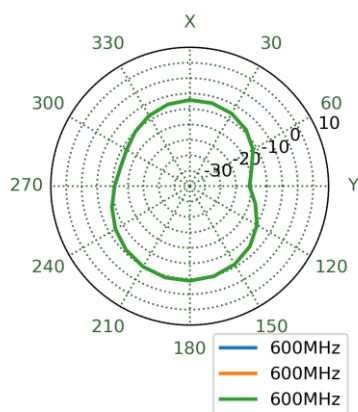
Tested on PAD.760.A Evaluation board(120x45mm)

4.2 On Evaluation Board 120*45mm 2D & 3D Radiation Patterns

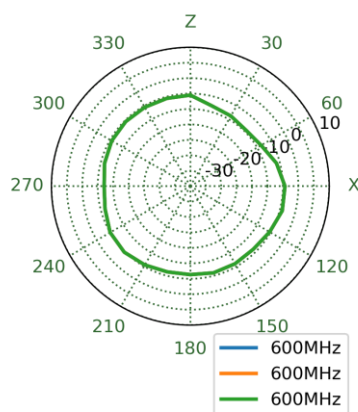
600MHz



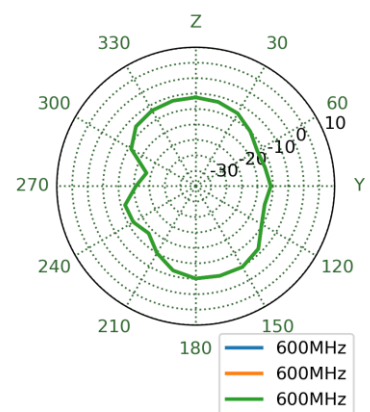
XY Plane



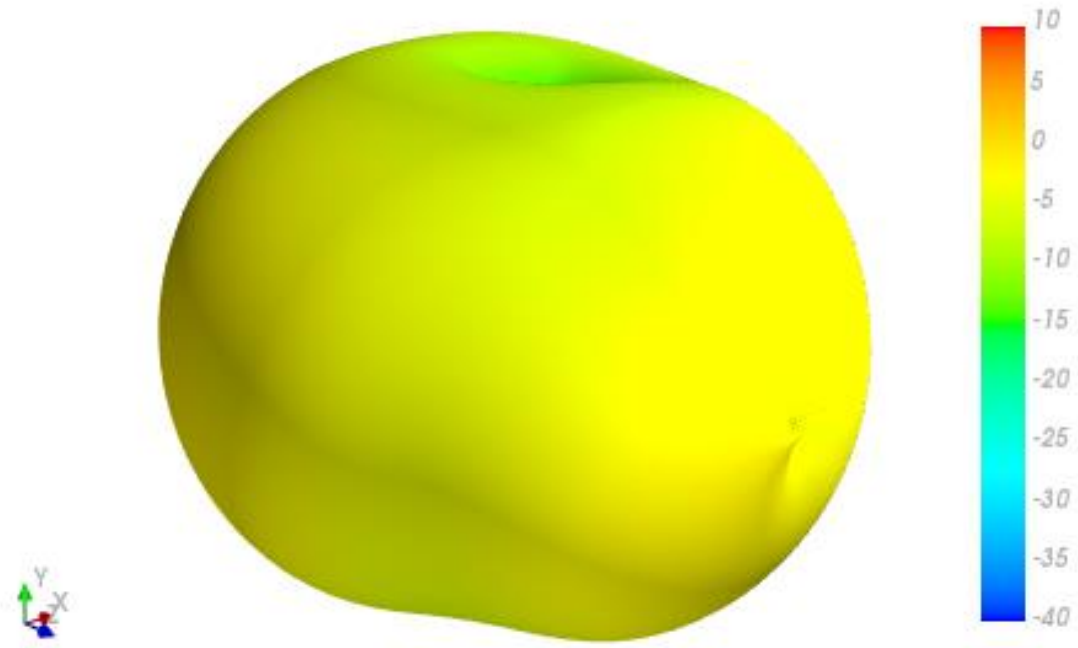
XZ Plane



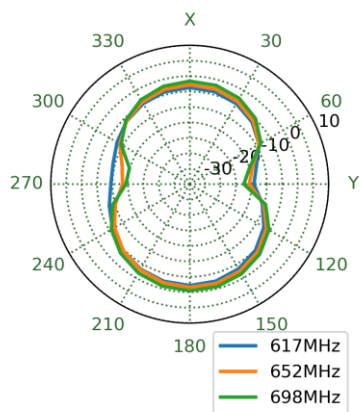
YZ Plane



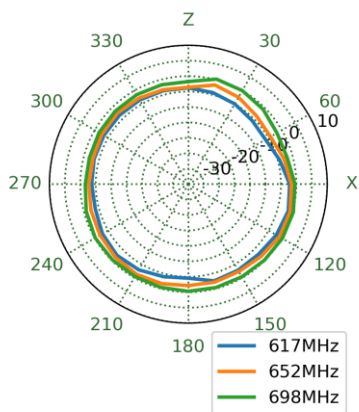
652MHz



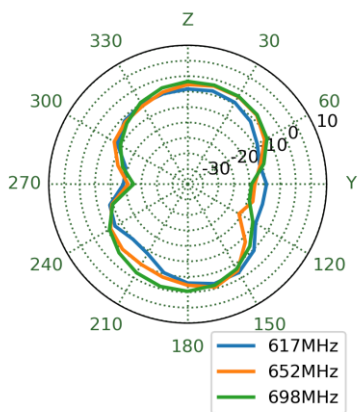
XY Plane



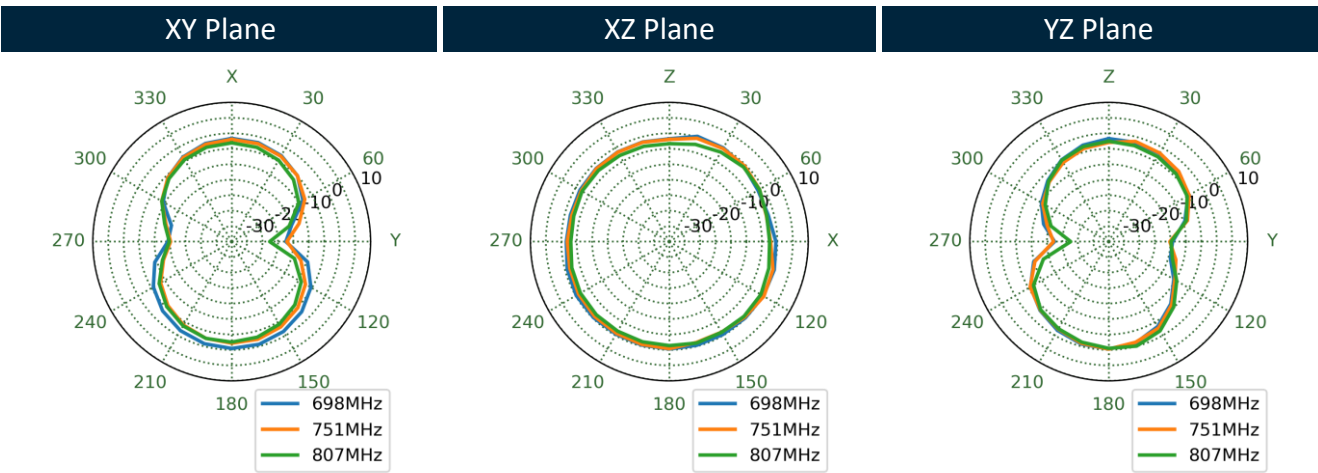
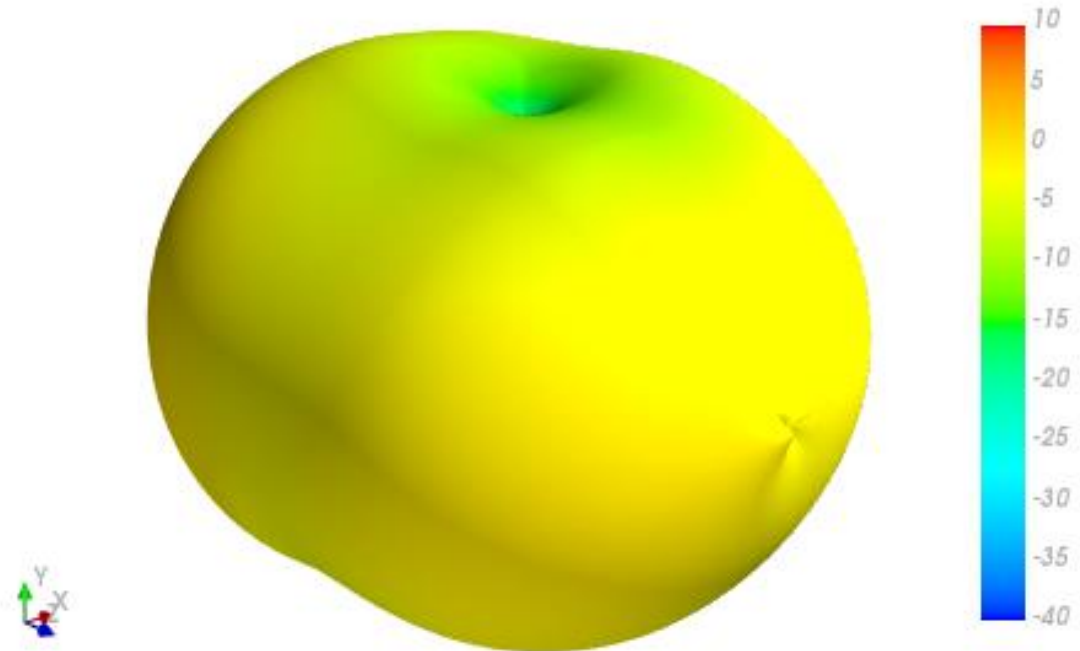
XZ Plane



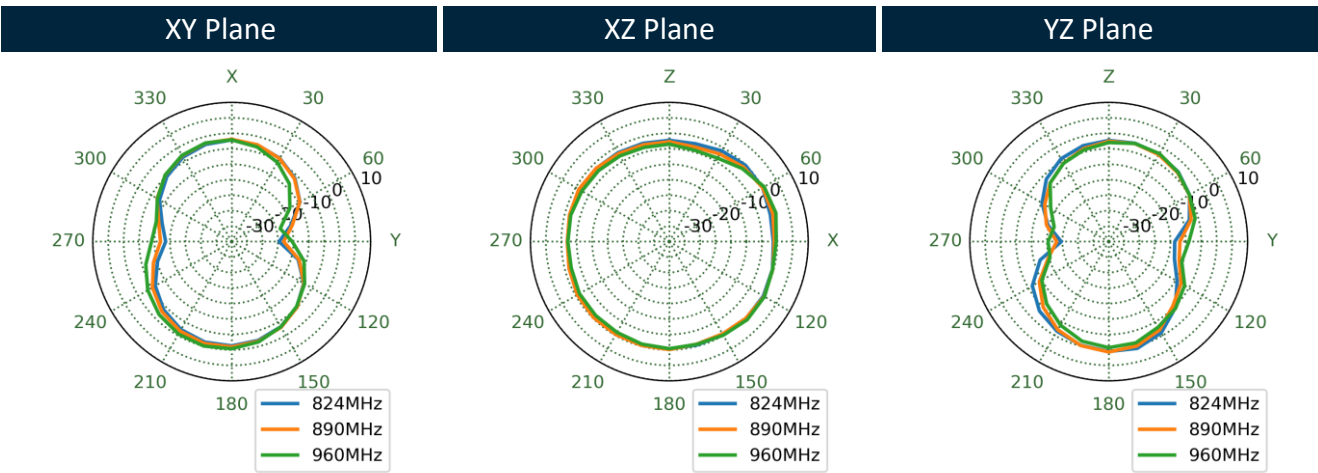
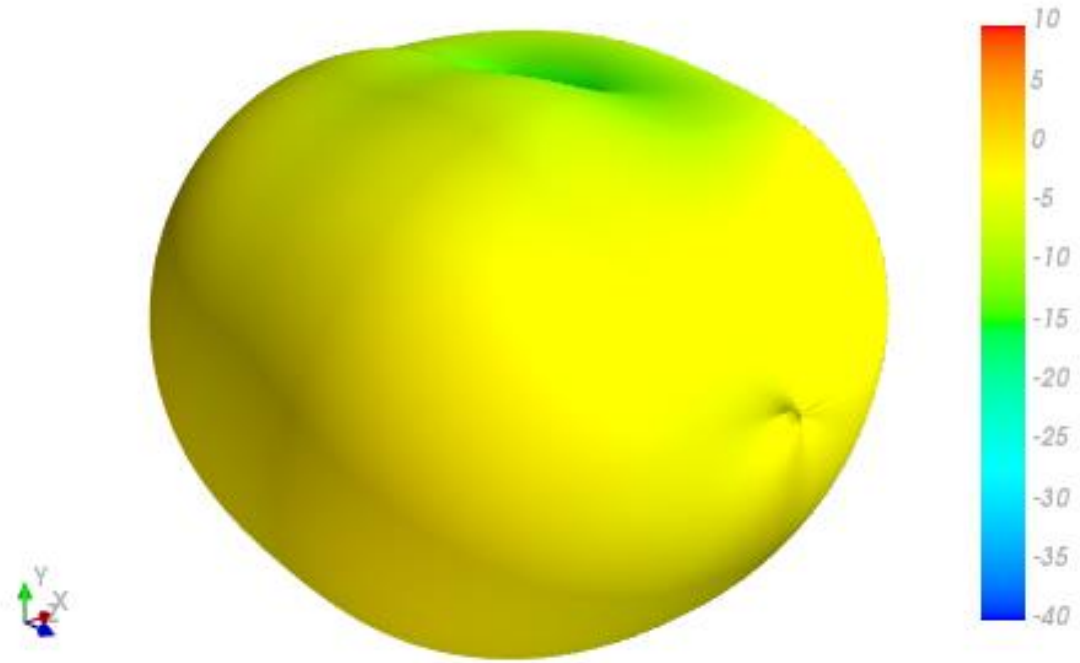
YZ Plane



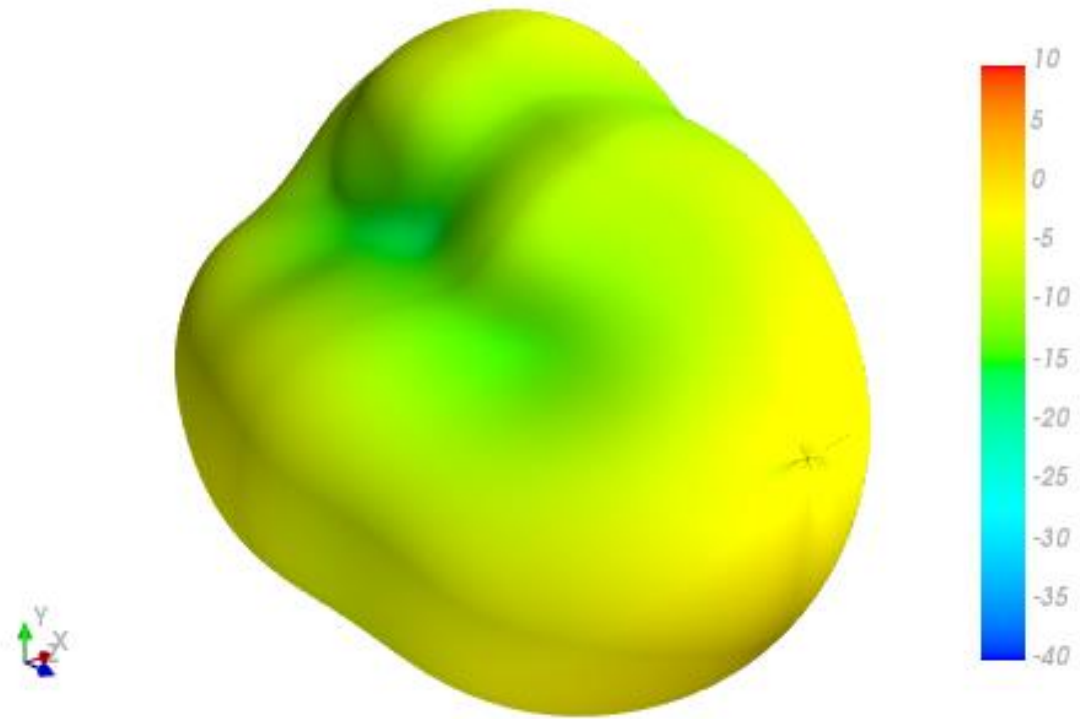
751MHz



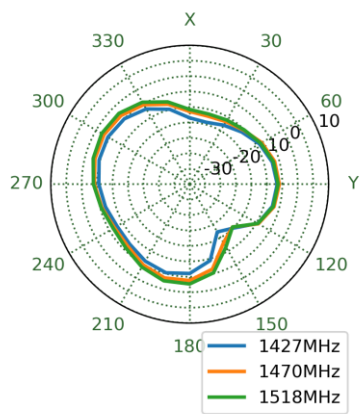
890MHz



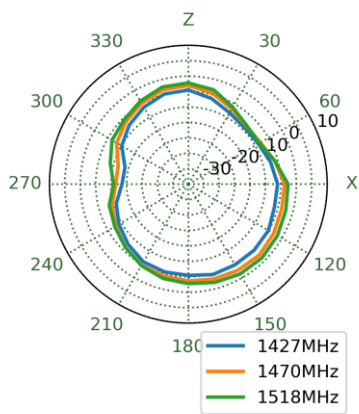
1470MHz



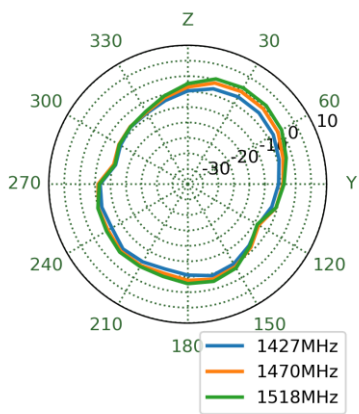
XY Plane



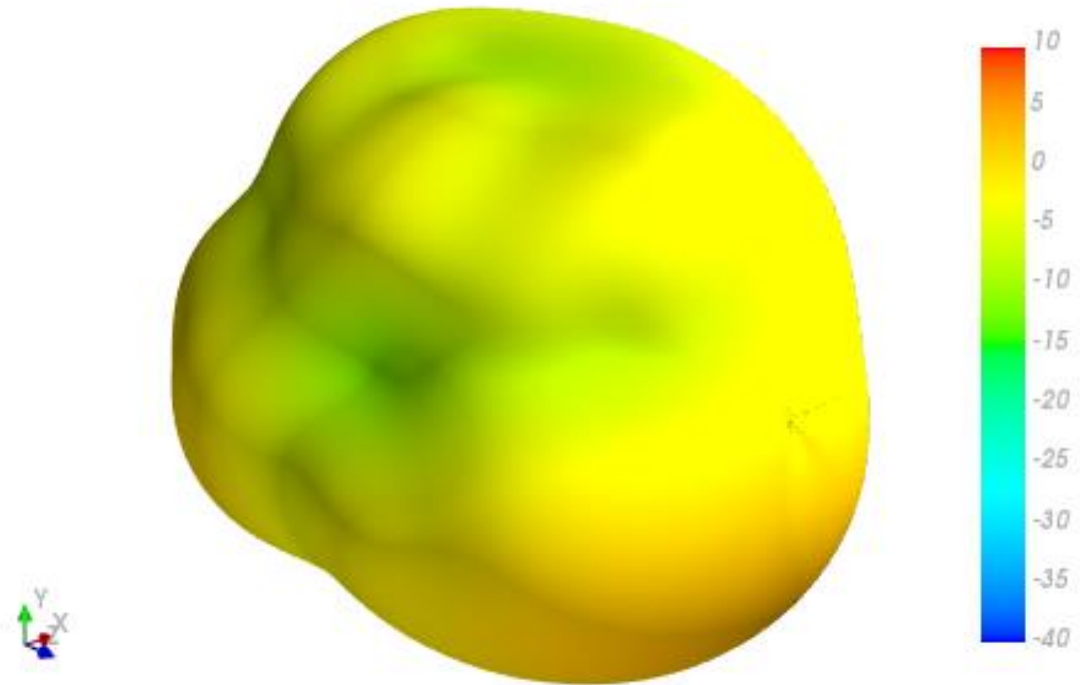
XZ Plane



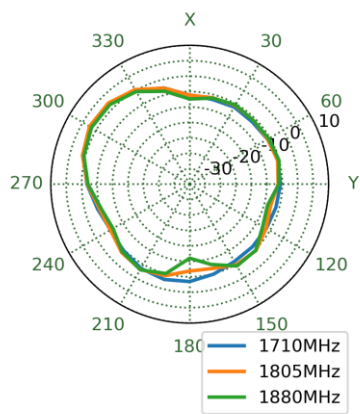
YZ Plane



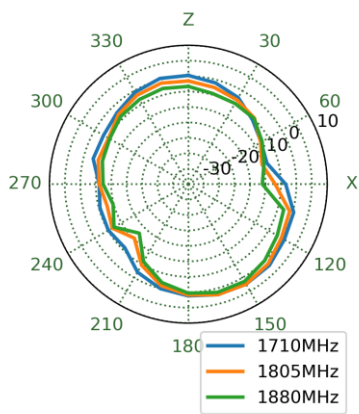
1805MHz



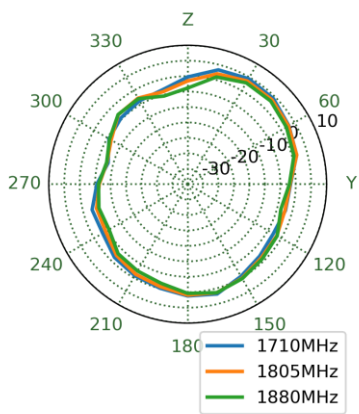
XY Plane



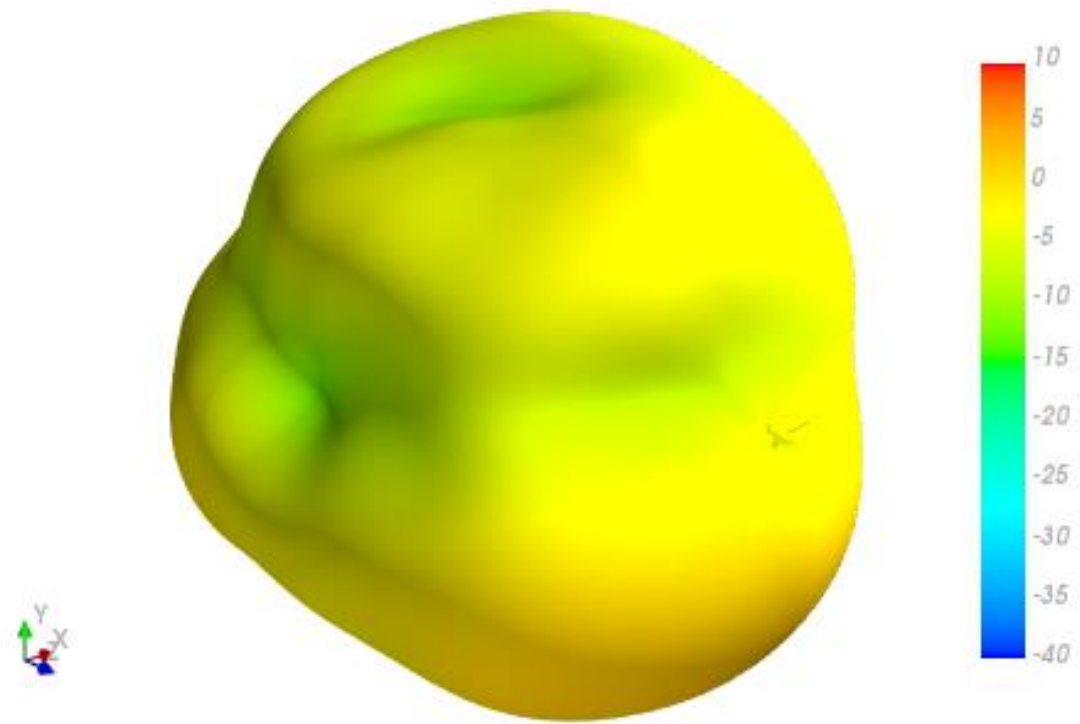
XZ Plane



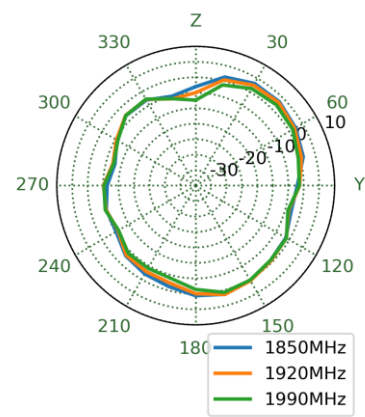
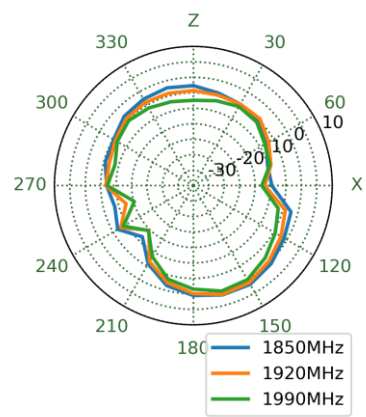
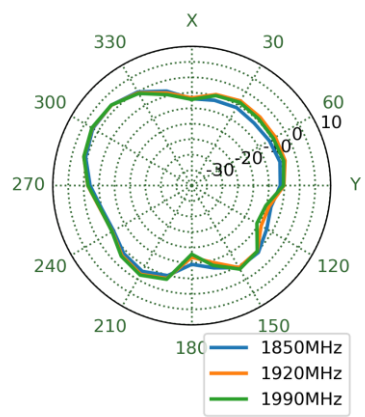
YZ Plane



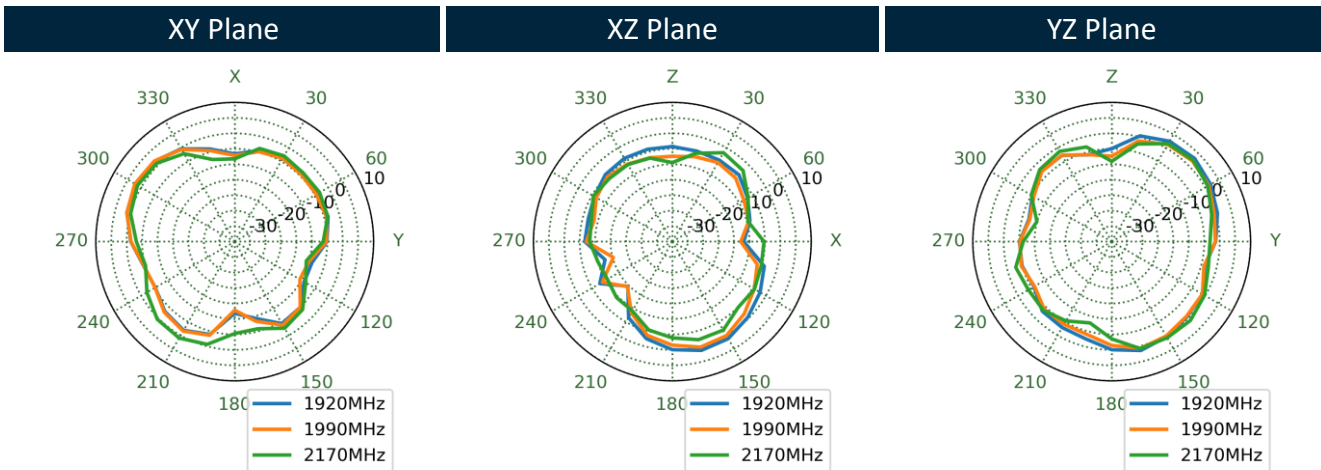
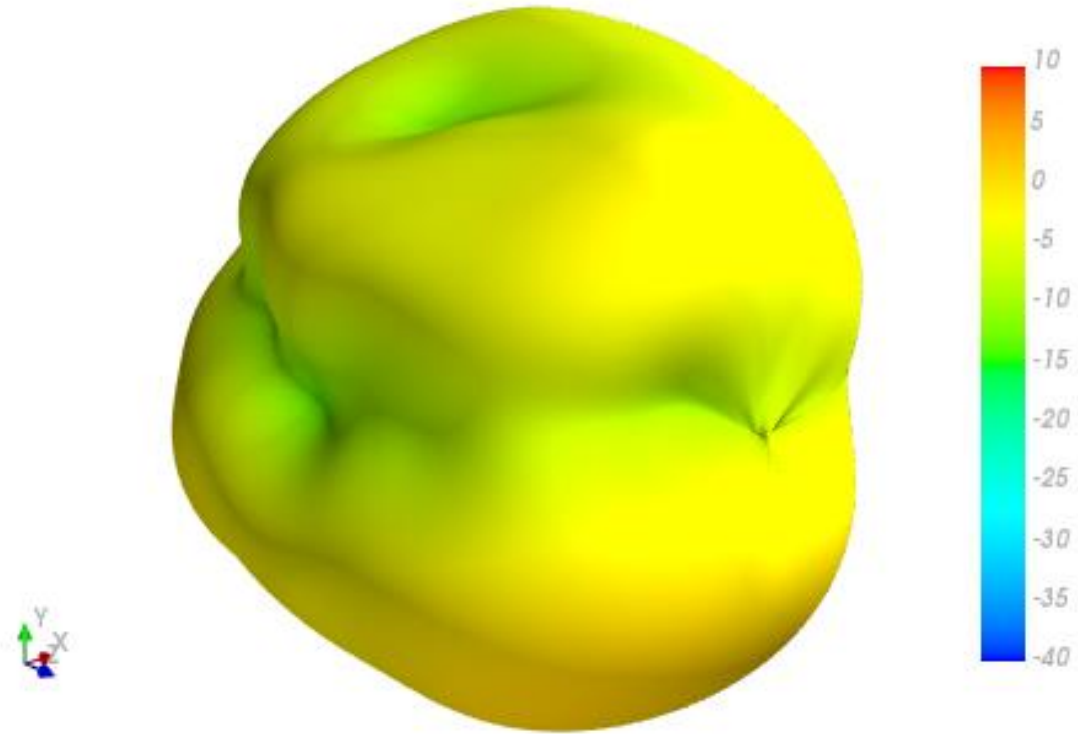
1920MHz



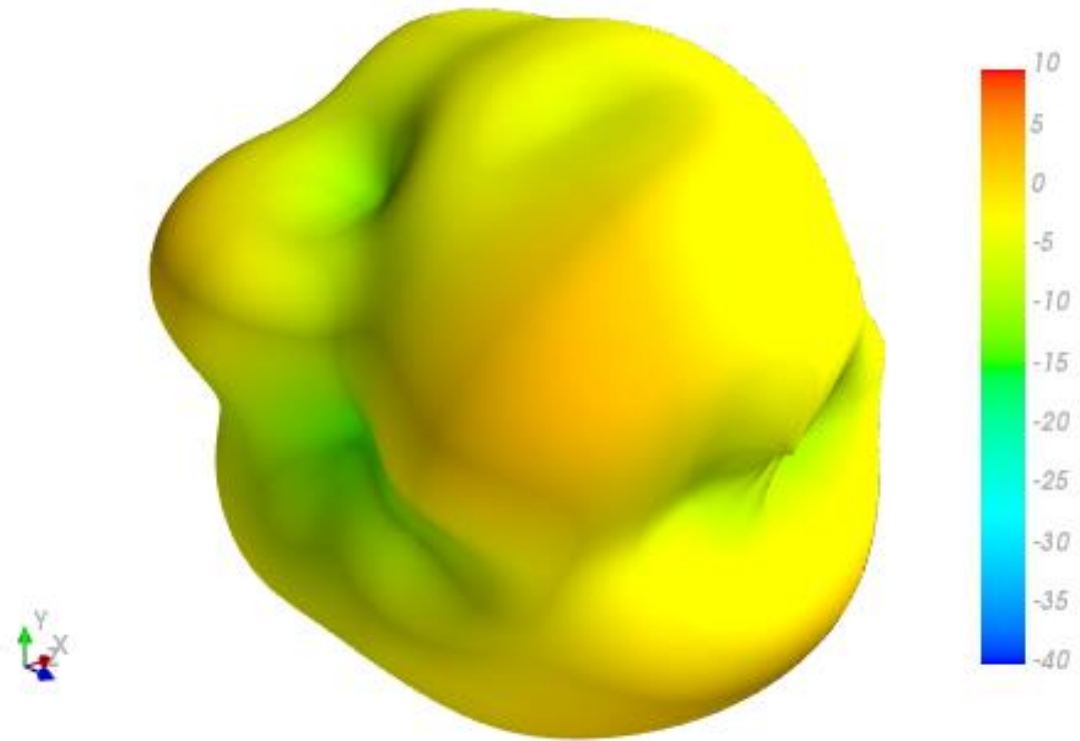
XY Plane XZ Plane YZ Plane



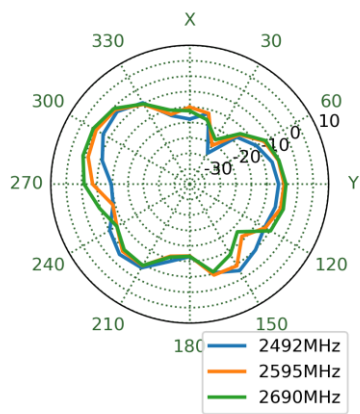
1990MHz



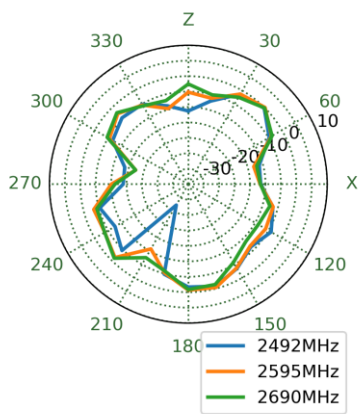
2595MHz



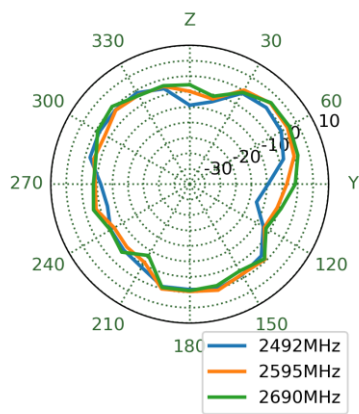
XY Plane



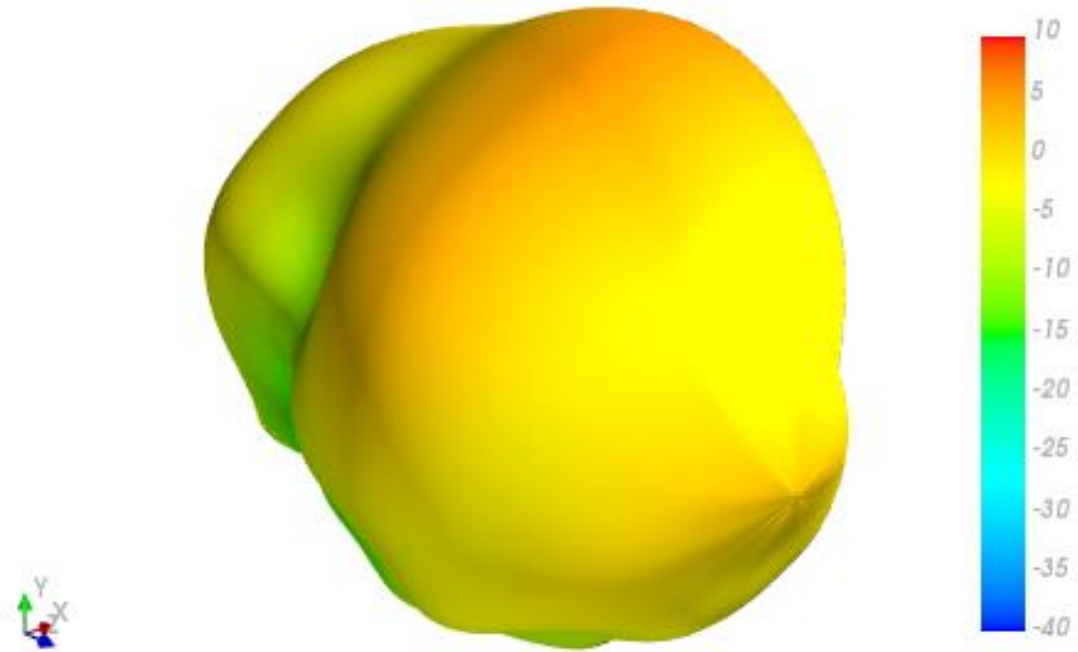
XZ Plane



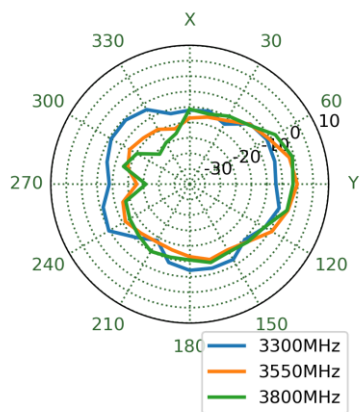
YZ Plane



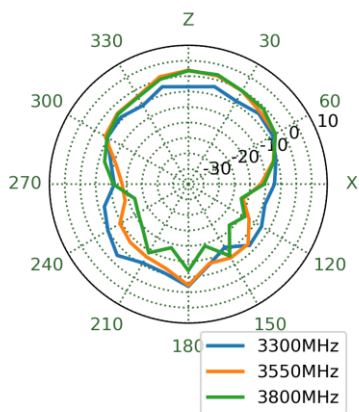
3550MHz



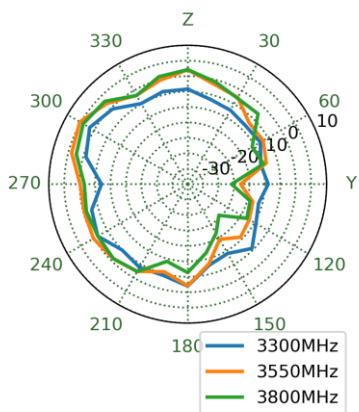
XY Plane



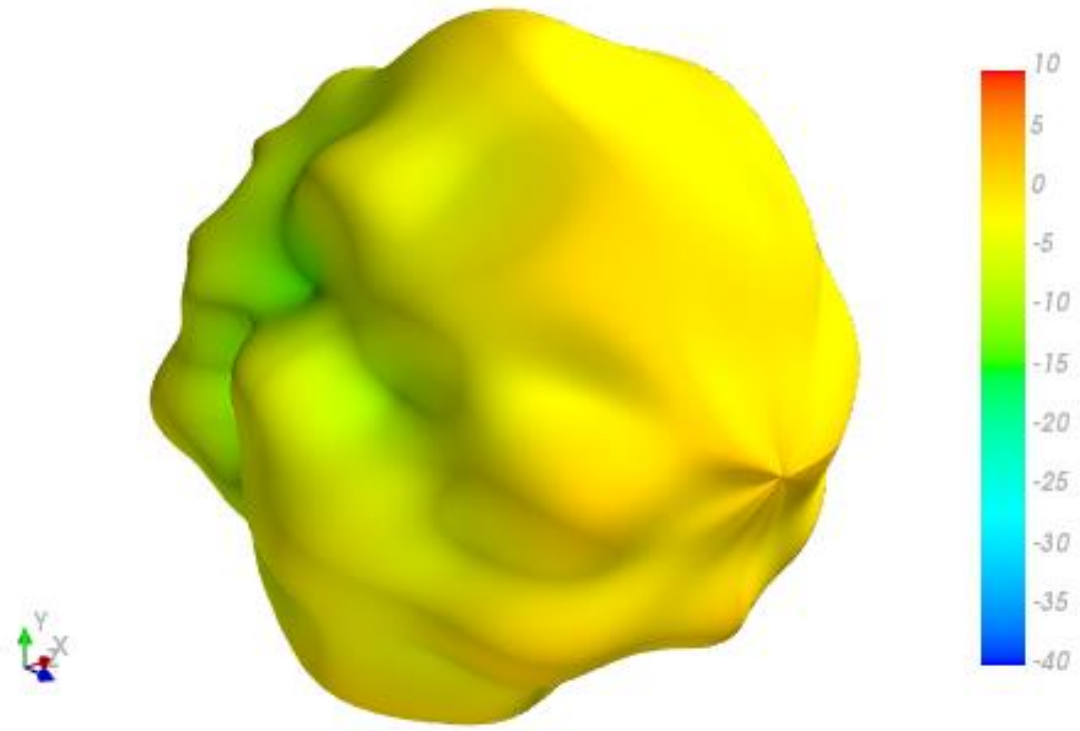
XZ Plane



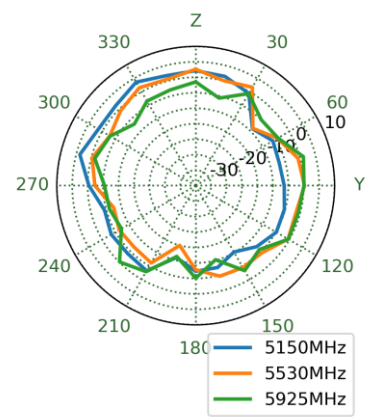
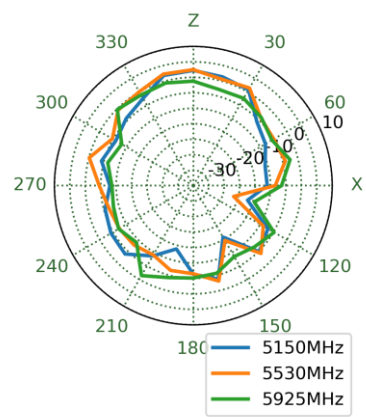
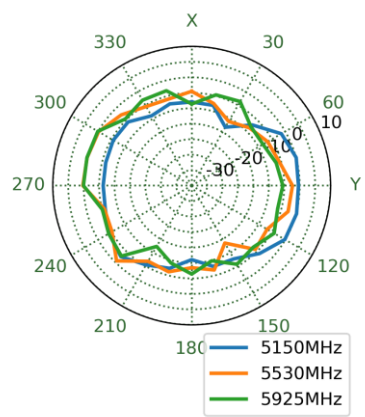
YZ Plane



5530MHz

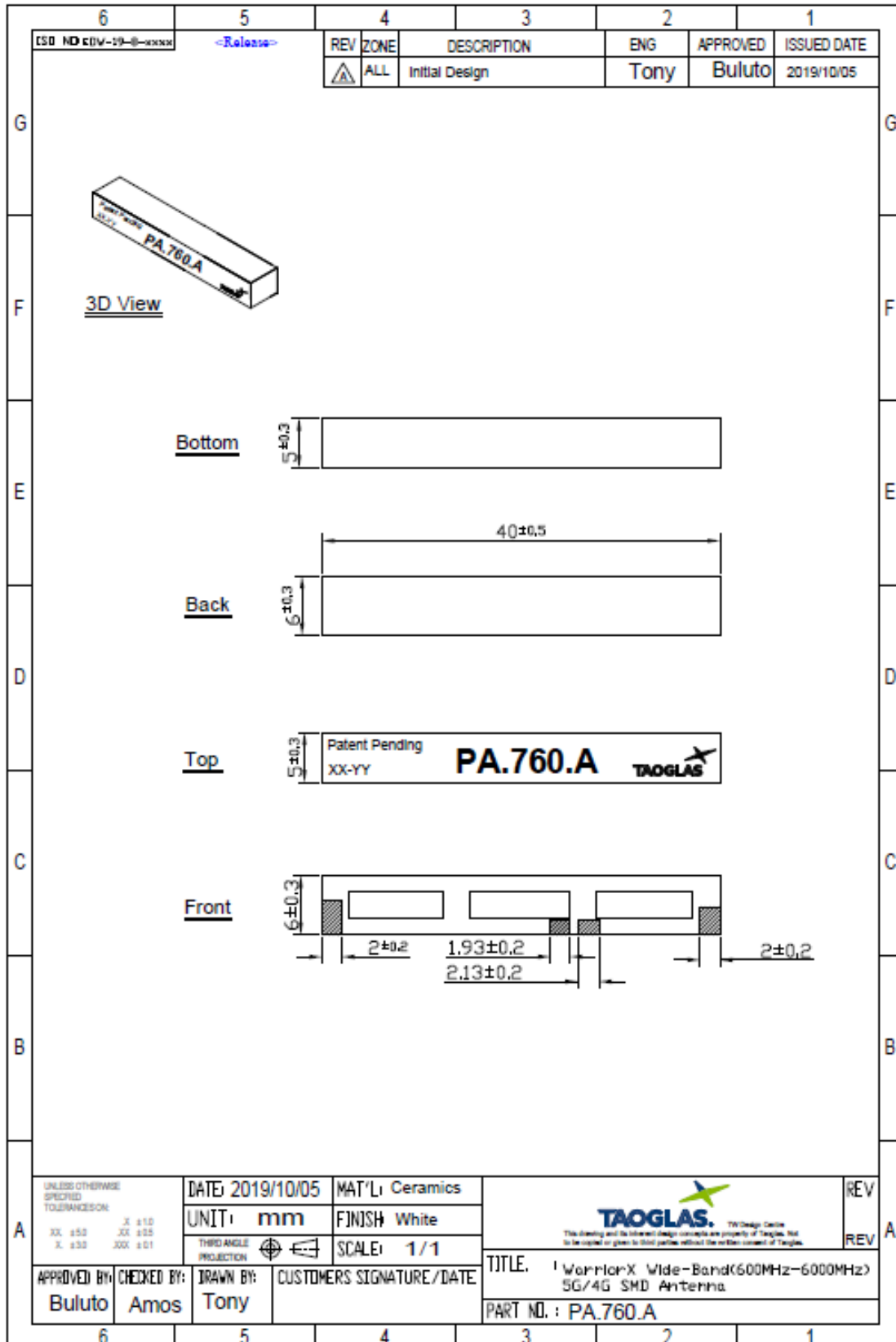


XY Plane
XZ Plane
YZ Plane



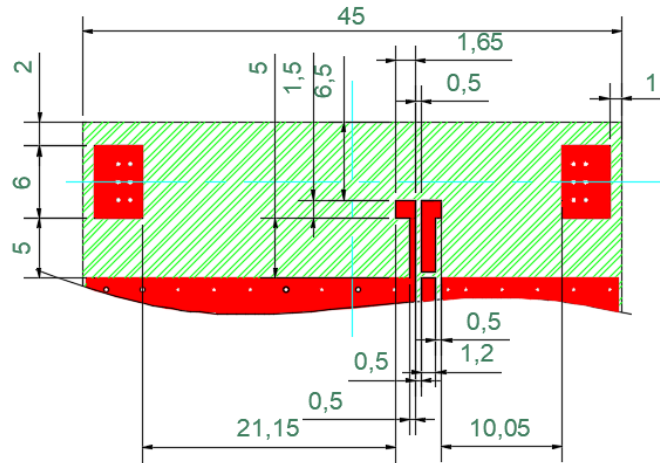
5. Mechanical Drawing (Units: mm)

5.1 Antenna Drawing



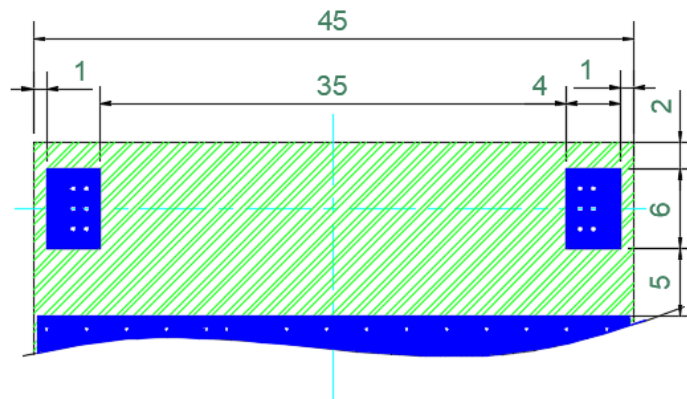
5.3 Copper Keep-Out Areas

Top Layer



Top View

Bottom Layer



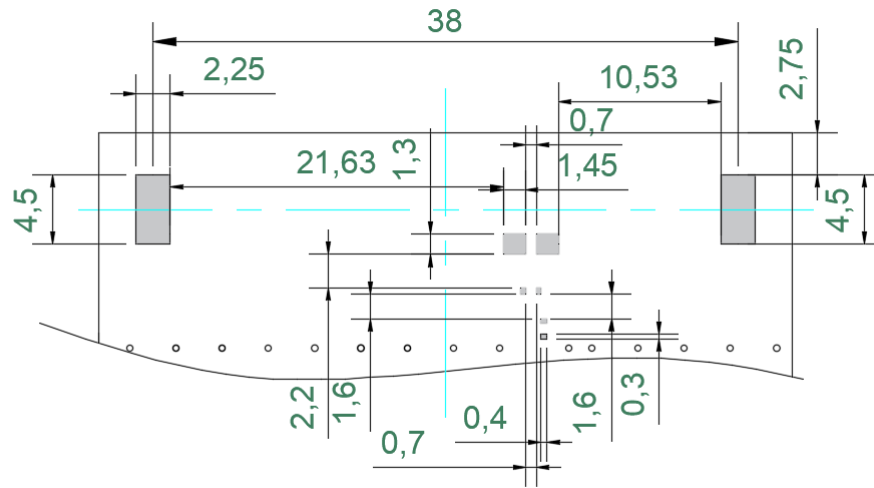
Bottom View

Note:

- 1. Copper area ■ ■
- 2. Ground Clearance Area

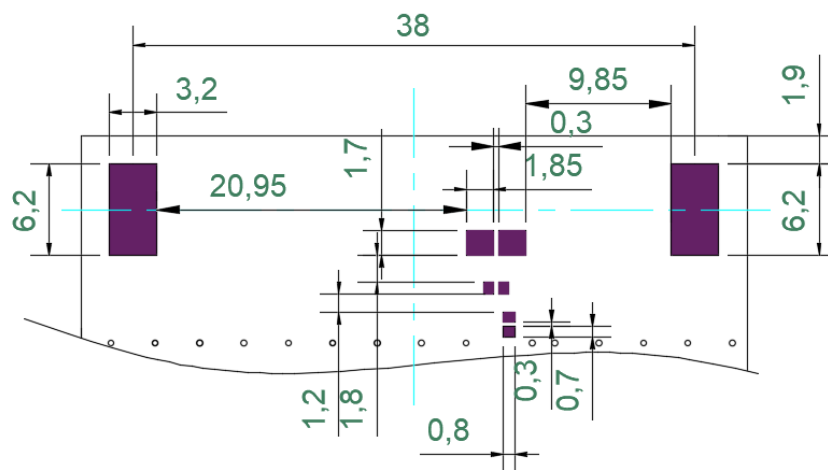
5.4 Solder Layer

Top Solder Paste



Top View

Top Solder Mask

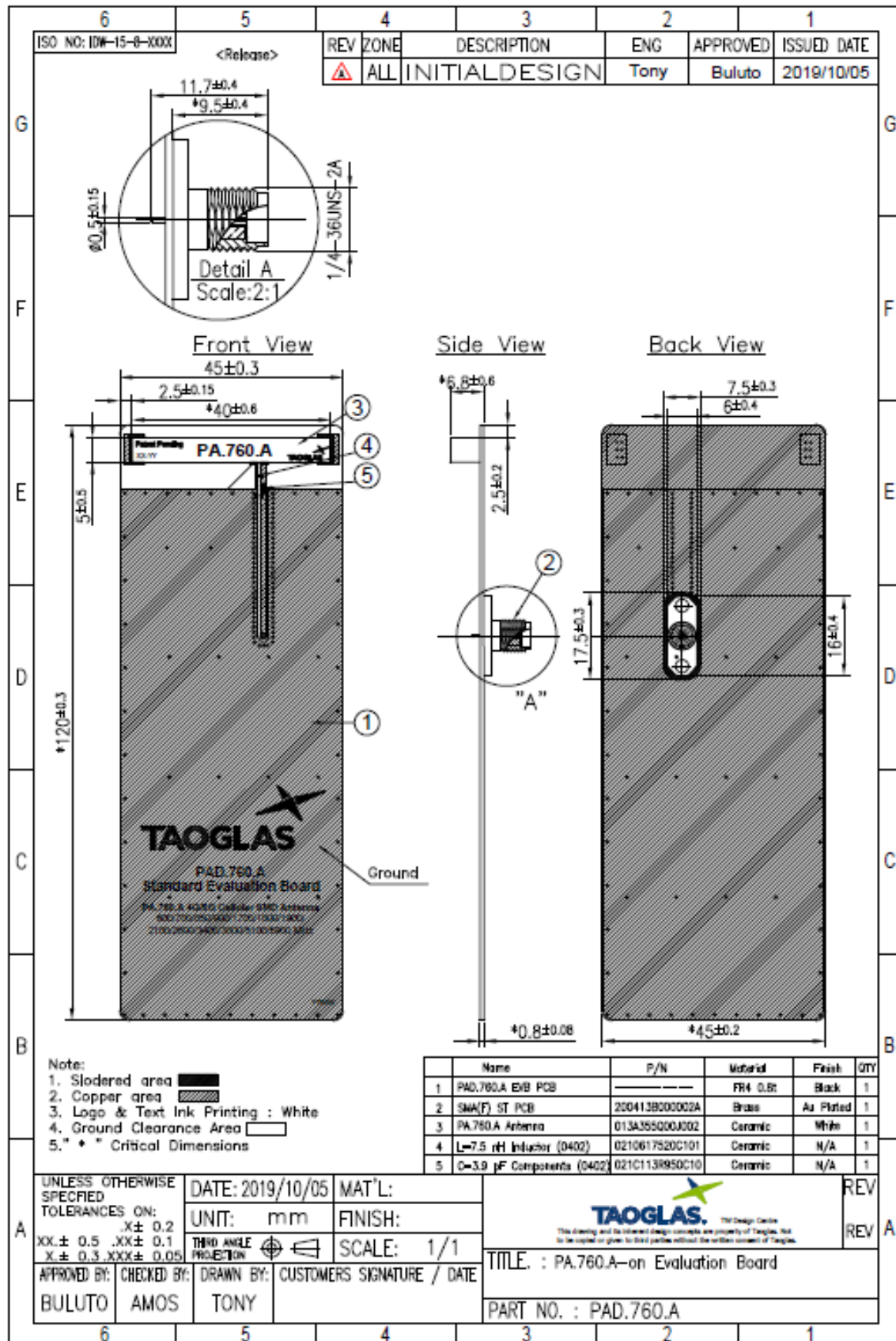


Top View

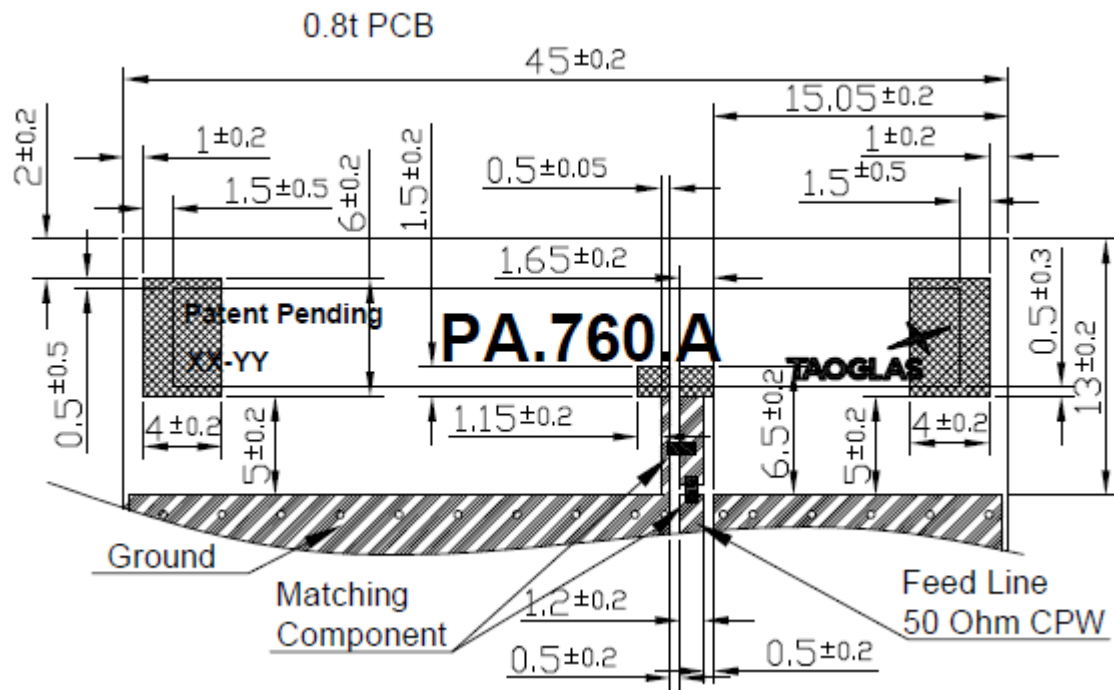
Note:

- 1. Top Solder Paste
- 2. Top Solder Mask

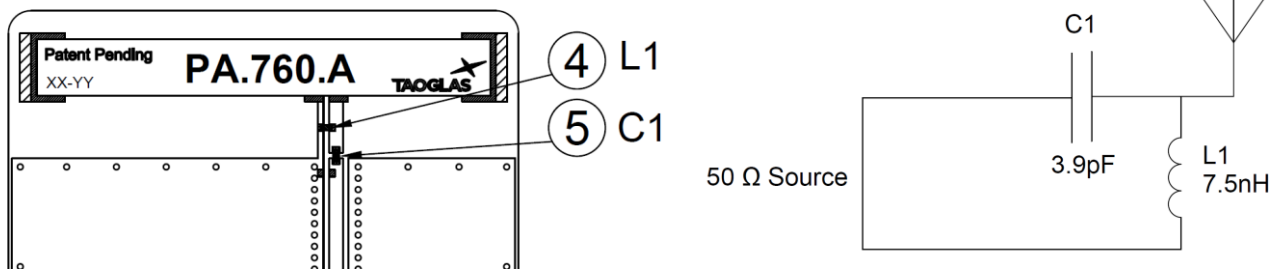
5.5 Evaluation Board



5.6 Footprint Dimensions



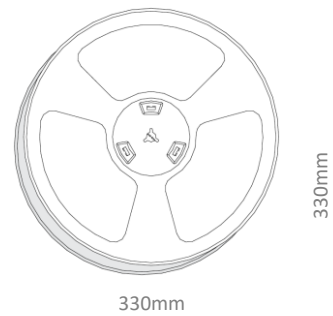
6. Evaluation Board Matching Circuit



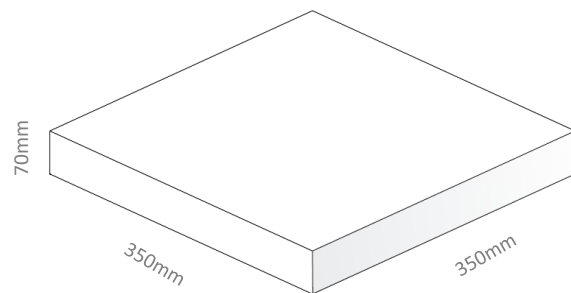
Circuit Symbol	Size	Description
L1	0402	7.5nH inductor ±5%/SMD0402/Murata/LQG15HS7N5J02D
C1	0402	3.9pF Capacitor 50V/±0.25PF/MURATA

7. Packaging

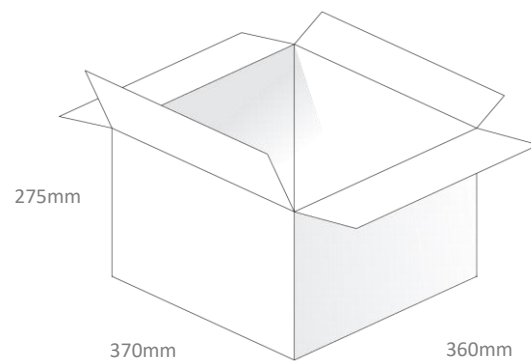
450 pc PA.760.A per Tape & Reel



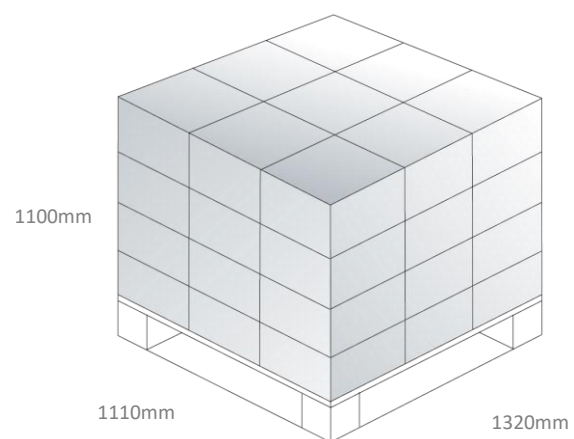
1 reel in small inner box
Dimensions: 350*350*70mm
Weight: 2.4Kg



1350 pcs in one carton
Dimensions: 370*360*275mm
Weight: 7.5Kg



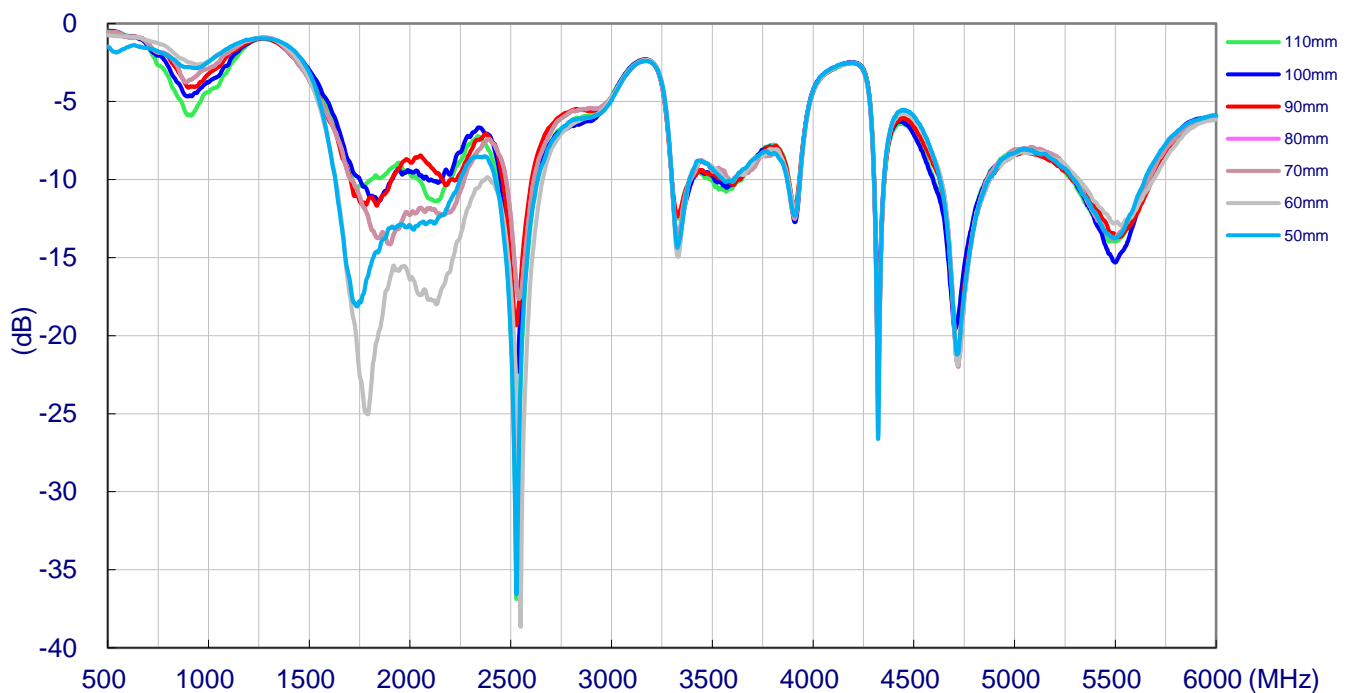
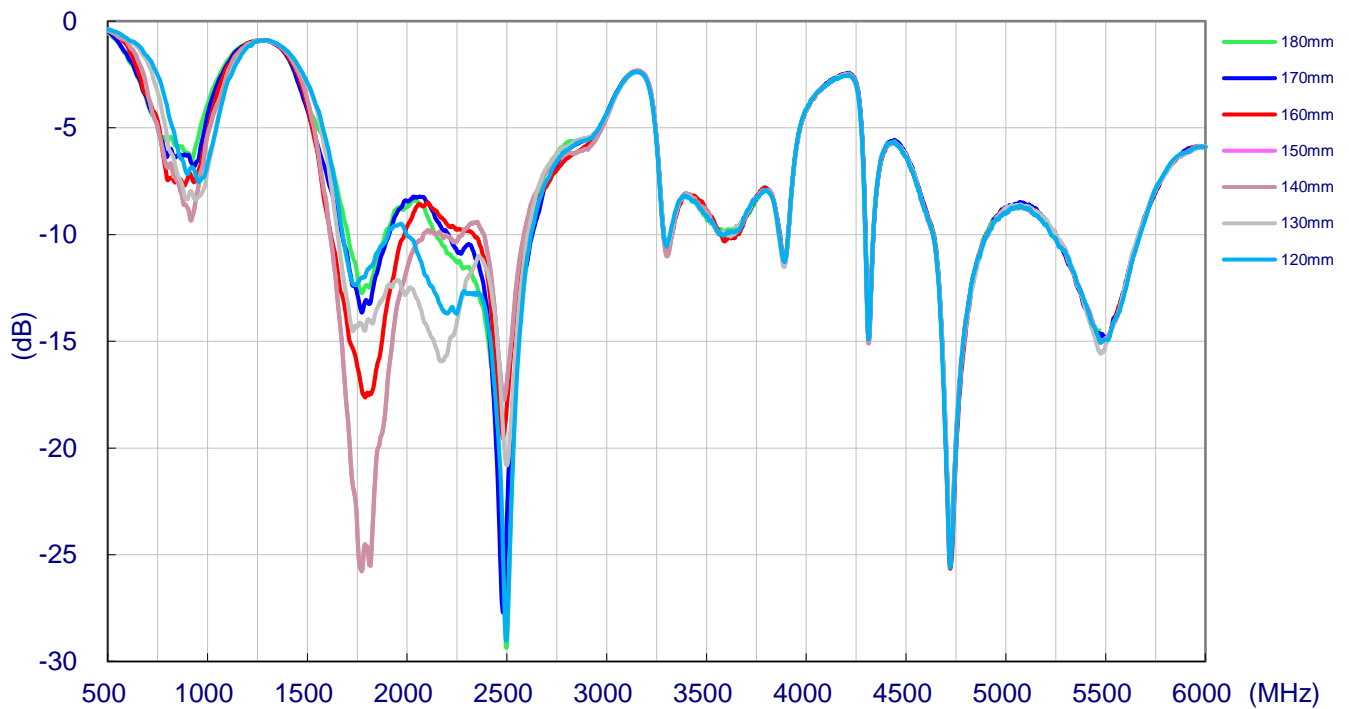
Pallet Dimensions:
1110*1320*1100mm
36 Cartons Per Pallet
9 Cartons Per Layer, 4 Layers



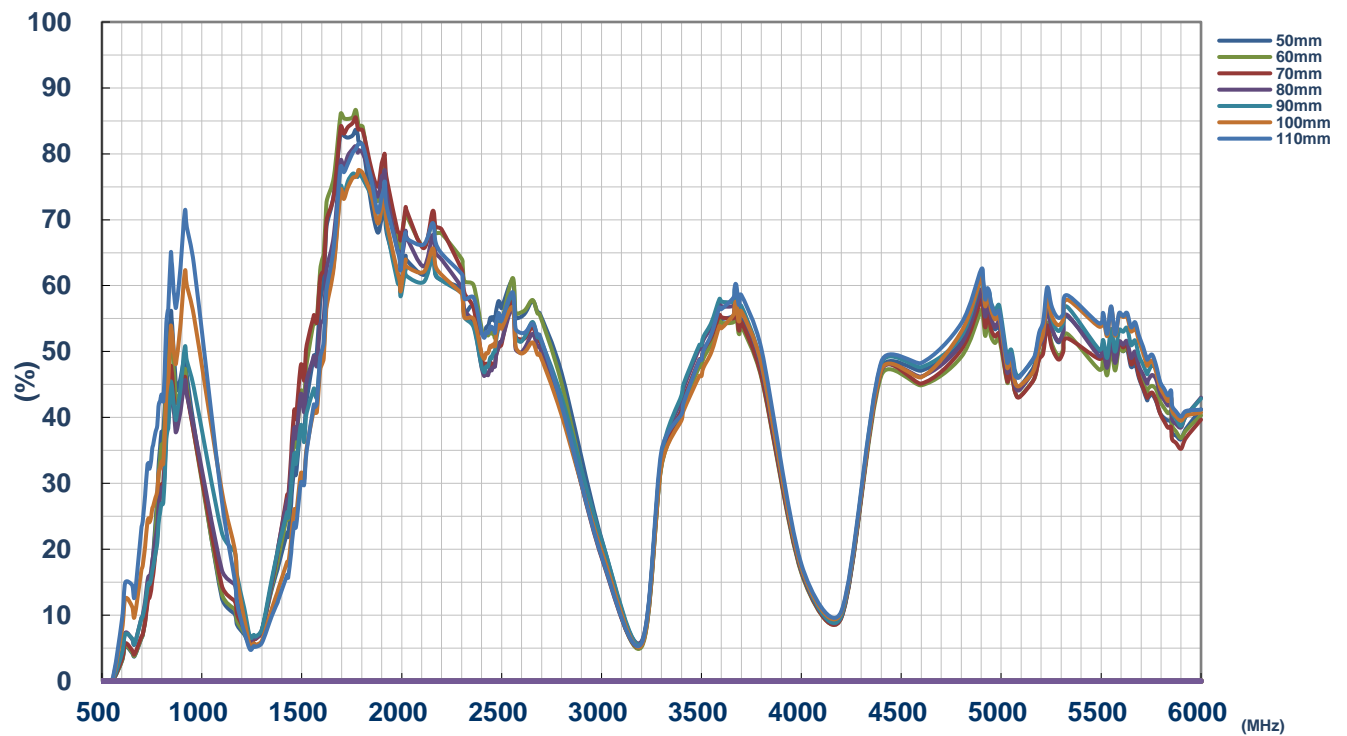
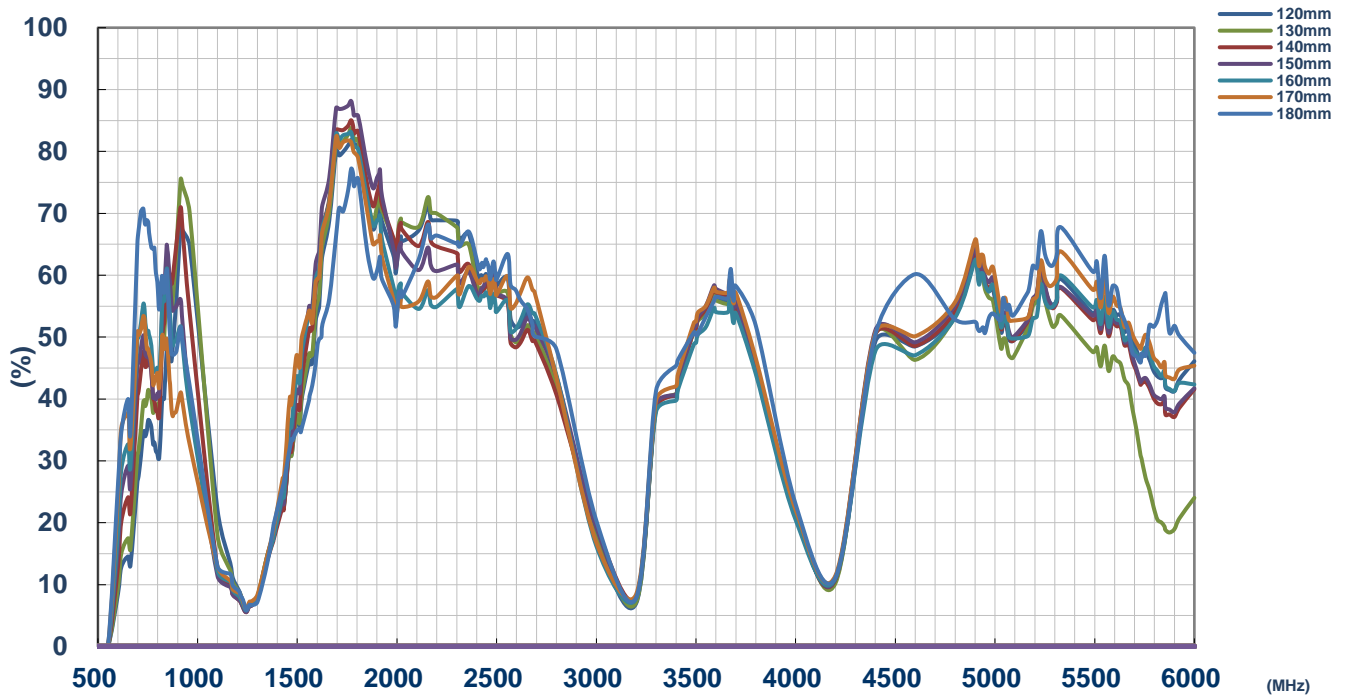
8. Application Note

The PA.760.A has been tested on various size ground planes (180 to 50mm), see the below graphs for performance details.

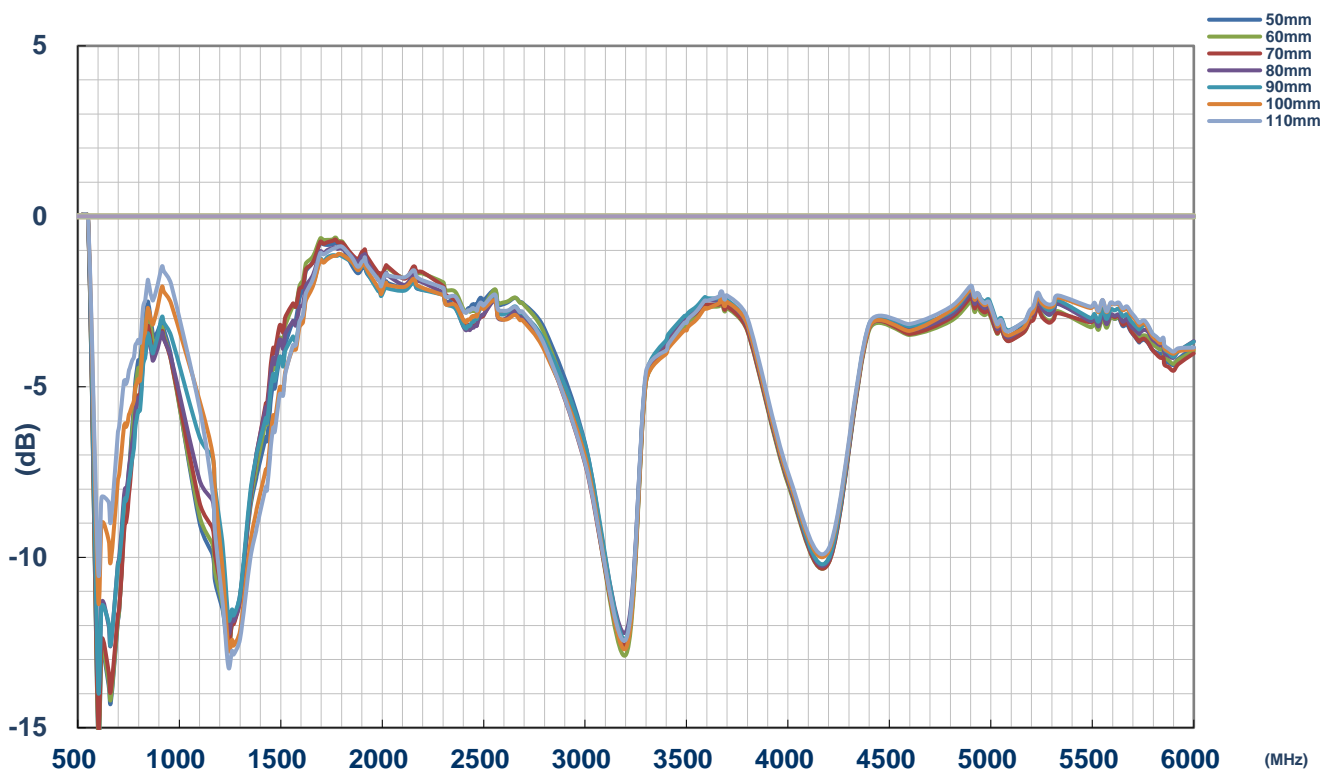
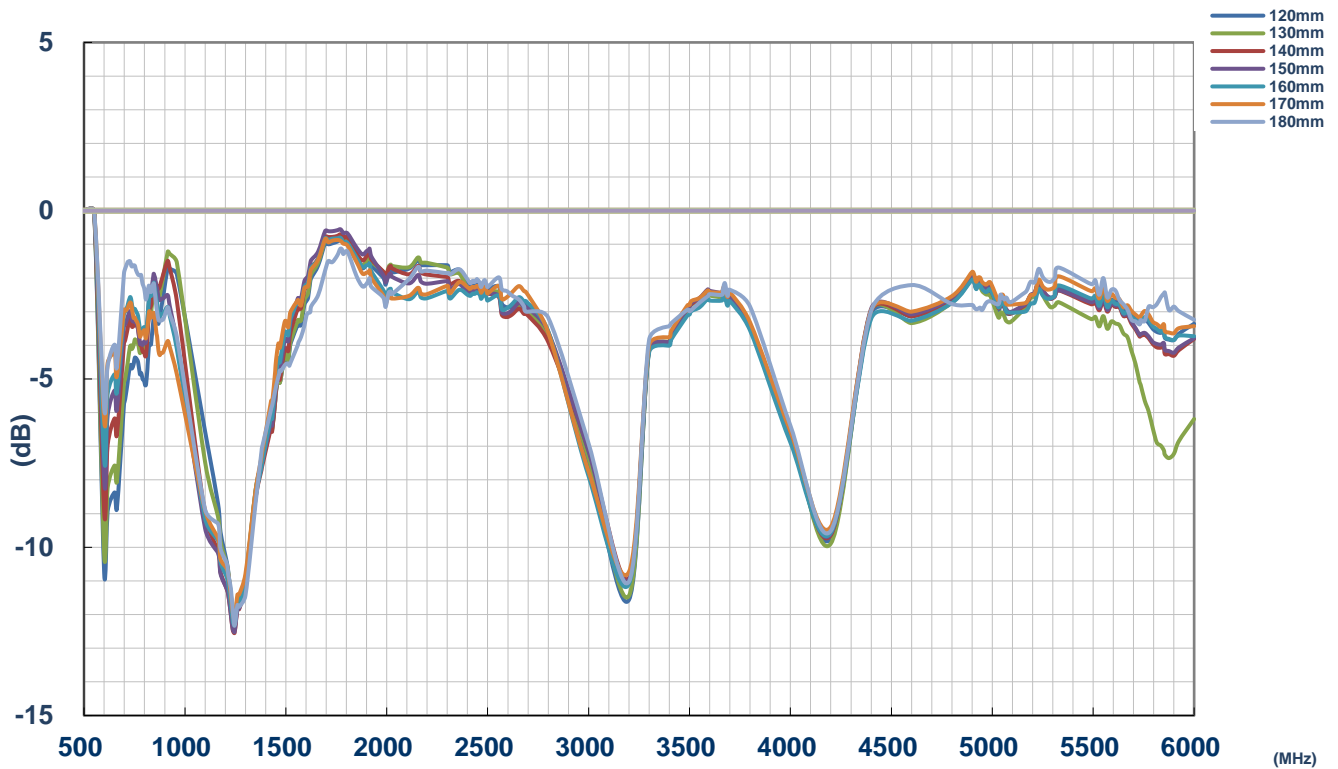
8.1 Return Loss



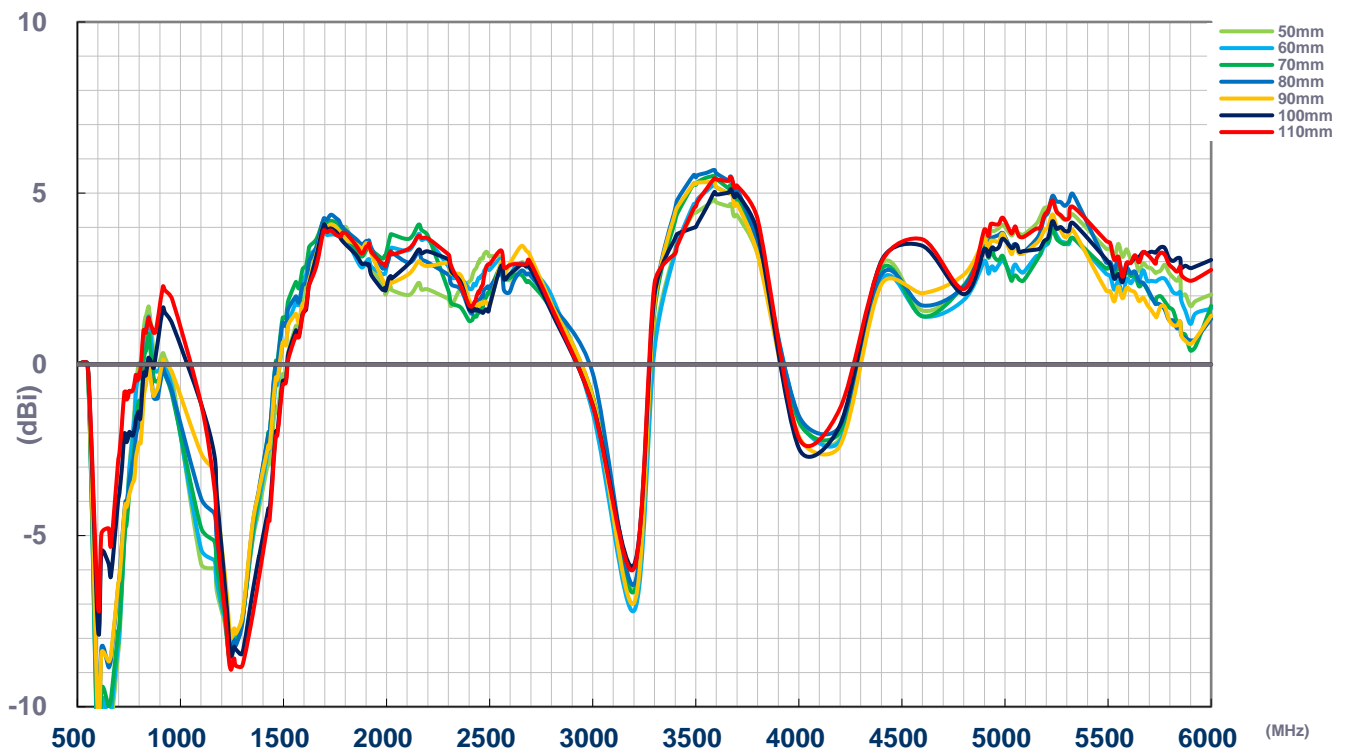
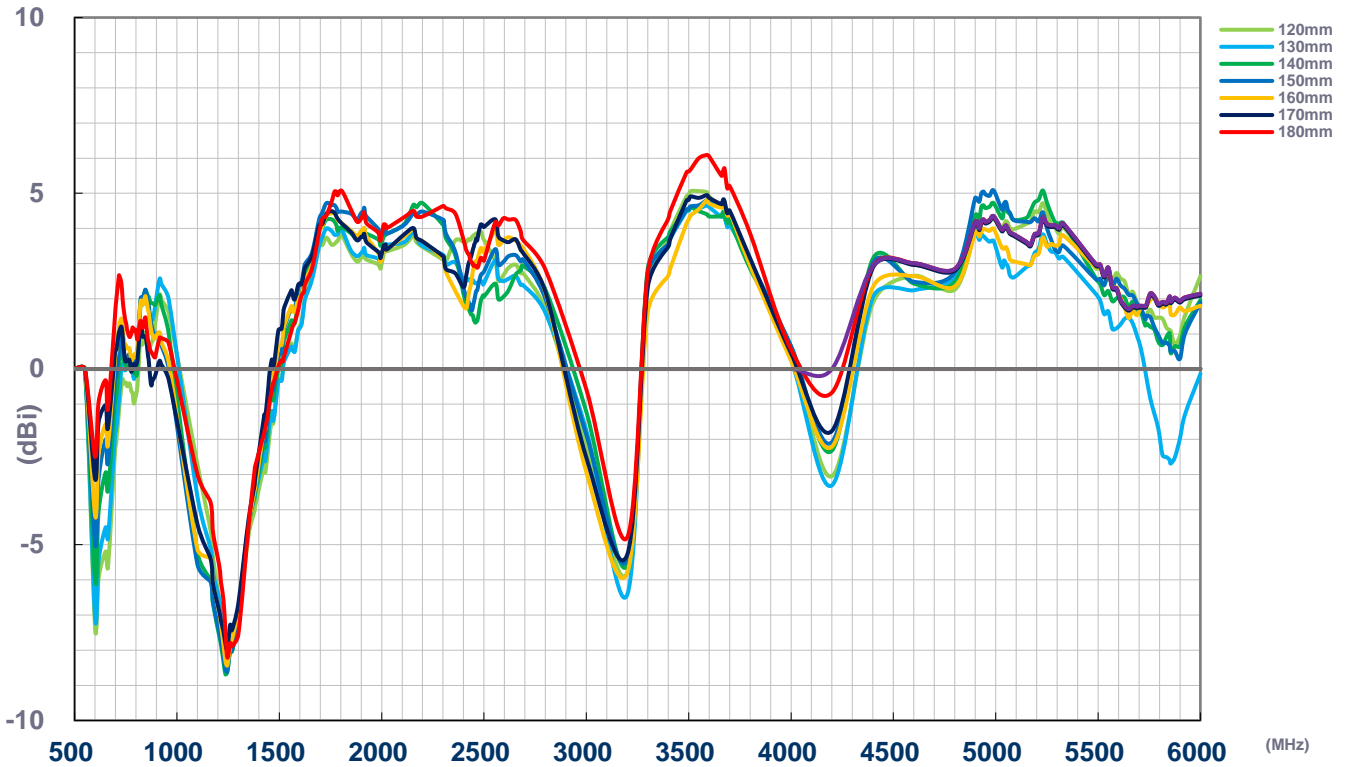
8.2 Efficiency



8.3 Average Gain



8.4 Peak Gain

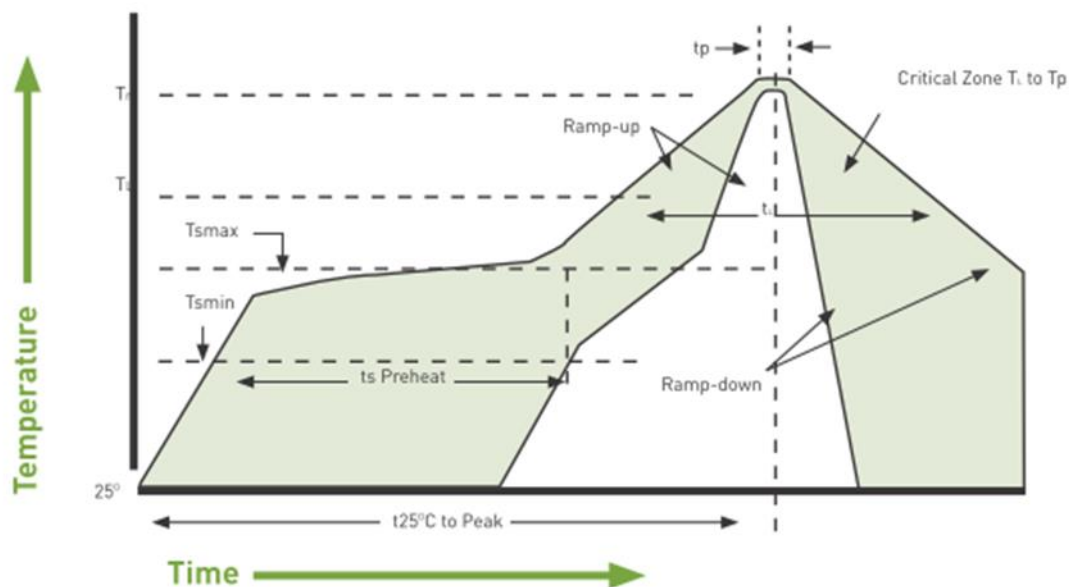


9. Solder Reflow Temperature

PA.760.A can be assembled following either Sn-Pb or Pb-Free assembly processes. The recommended soldering temperatures are as follows:

Phase	Profile Features	Sn-Pb Assembly	Pb-Free Assembly (SnAgCu)
Ramp-Up	Avg. Ramp-Up Rate (T _{smax} to T _p)	3°C/second (max)	3°C/second (max)
Preheat	Temperature Min (T _{smin})	100°	100°
	Temperature Max (T _{smax})	150°	150°
	Time (t _{smin} to t _{smax})	60-120 seconds	60-120 seconds
Reflow	Temperature (T _L)	183°C	217°C
	Total Time Above T _L b(t _L)	60-150 seconds	60-150 seconds
Peak	Temperature (T _p)	235°C	260°C
	Time (t _p)	10-30 seconds	20-40 seconds
Ramp-Down	Rate	6°C/second (max)	6°C/second (max)
Time from 25°C to peak Temperature		6 minutes max	8 minutes max

Temperature profile – (green area) for the assembly process in reflow ovens



Changelog for the datasheet

SPE-19-8-134 – PA.760.A

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Date:	2020-11-05
Changes:	Specifications table amended
Changes Made by:	Dan Cantwell

Previous Revisions

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Notes:	Initial Release
Author:	Jack Conroy



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